

# X12 Server Solutions

Supporting 3<sup>rd</sup> Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable Processors (*Ice Lake*)









# INTRODUCING SUPERMICRO X12 GENERATION



# Better

Better Performance Per Watt and Per Dollar

# Faster

40%-60% Better Performance on Cloud Workloads

# Greener

Reduced Environmental Impact & Lower TCO



### OPTIMIZED SYSTEMS FOR YOUR WORKLOAD

- Over 100 Building Block Optimized Designs
- Maximum Processor, Memory and I/O Performance
- Max Performance, High Volume Cloud, High Efficiency Multi- Node, Mainstream

#### **OPEN ARCHITECTURES**

- OpenBMC, OCP v3.0 SFF Cards
- New Supermicro AIOM Cards Provide I/O Flexibility with OCP Superset

#### **SECURE**

 Enhanced Security with Hardware Root of Trust, Total Memory Encryption, Software Guard Extension

#### **MANAGEABLE & SERVICEABLE**

- New Web Management Interface
- Tool-less Designs
- Global Service & Support
- Performance, High Volume Cloud, High Efficiency Multi- Node, Mainstream

### FIRST-TO-MARKET WITH MAXIMUM PERFORMANCE

- Thermal Capacity Supports Highest Clock
   Speeds
- Support for Full Memory Configuration and Bandwidth

#### **CPU & MEMORY**

- On Average 62% Better Performance on Network and 5G Workloads
- Web (Crypto) Acceleration
- DDR4-3200MHz
- 1.6x Memory Bandwidth
- 2.66x Memory Capacity

#### I/C

- PCI-E 4.0
- 2x I/O Bandwidth

#### SUPERBLADE®:

 Advanced Networking with 200G InfiniBand Switch, and up to 4x 25GbE Switches

#### **BEST-IN-CLASS WORKLOAD PERFORMANCE**

 Market-Leading GPU Servers for AI/ML and HPC

#### MAXIMUM POWER EFFICIENCY

- Both Free Air and Water Cooled
- Titanium-Level (96%) Power Supplies

#### **MULTI-NODE SYSTEMS**

 15-20% Lower Power Costs with Optimized Shared Resource Designs

#### LONGEVITY

• Multi-Generation Infrastructure for up to 65% CAPEX Savings

#### **SYSTEM REFRESH**

- Modular Upgrades for Maximum Performance and Efficiency
- Select Component Refresh Reduces e-Waste

# Optimized for IT, Data Center, Embedded, HPC and Cloud Computing



Specifications.



X12 CloudDC

Overview... .30-31 Specifications..



X12 SuperStorage®

Overview.... Specifications......



Overview.... Specifications..





Specifications.....



X12 BigTwin®

Specifications...



X12 SuperBlade®

Overview...... Specifications......



X12 Mainstream

Overview..... Specifications..... Motherboards...



X12 FatTwin®

Overview.... ..15 Specifications...



X12 SuperWorkstations

Specifications..



Motherboards

DP Motherboards.... . 59-60 DP/UP Motherboards.... 61-64



X12 Ultra & Ultra-E

Specifications......



Overview..... Specifications....



X12 Hyper & Hyper-E

Overview..... Specifications......



Overview..... . 16 Specifications.....



X12 WIO

Overview... .20 Specifications... Motherboards.. .60,62



Software / AIOM

System Management Software...... 22 AIOM Networking Cards......

# **X12 GRANDTWIN**<sup>®</sup> Multi-node Architecture with Front I/O

# Purpose-built single-socket architecture with 3rd Gen Intel® Xeon® Scalable processors

16 DIMM slots per node for maximum memory footprint

Flexible configuration designed for better cost savings

Field serviceable from front/cold aisle to reduce downtime for higher availability

Flexible front I/O configuration designed to help reduce cable complexities

### 2U 4-Node



SYS-210GT-HNTF (Front View)

AIOM Ready

#### 2U 4-Node Front I/O GrandTwin®



Up to 4 NVMe/SATA drives per node



Up to 4 SATA/SAS drives per node

#### Highly Configurable Single Processor Systems with Front I/O

GrandTwin® is an all-new architecture purpose-built for single-processor performance. The design maximizes compute, memory and efficiency to deliver maximum density. Powered by Intel® Xeon® Scalable processors, GrandTwin's flexible modular design can be easily adapted for a wide range of applications, with the ability to add or remove components as required, reducing cost.

All I/O and node trays are fully accessible from the cold aisle, simplifying installation and servicing in space-constrained environments. Flexible storage and networking options are available via front AIOM modules, allowing countless custom configurations.

- MEC (Multi-Access Edge Computing)
- HPC
- Cloud Gaming
- Multi-Purpose CDN (Content Delivery
- · Network)
- High-Availability Cache Cluster
- · Telco Edge Cloud
- EDA (Electronic Design Automation)
- Mission-Critical Web Applications

# **X12 BIGTWIN**<sup>®</sup> Leading Multi-node Architectures

Highly configurable 2U 4-node and 2U 2-node systems

3rd Gen Intel® Xeon® Scalable processors, 2 per node, up to 270W TDP

All-hybrid hot-swappable drive bays - NVMe, SAS or SATA (2.5" or 3.5" drives) - Up to 12 NVMe drives per node.

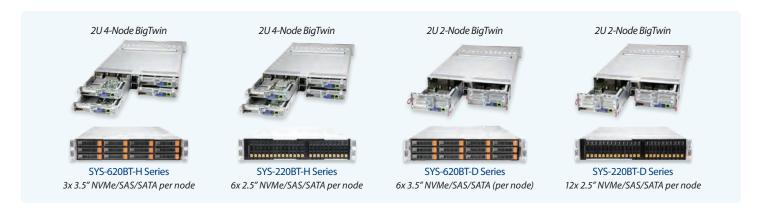
16 DIMMs + 4 Intel Optane Persistent Memory 200 series per node

PCI-E 4.0 AIOM (OCP 3.0 compliant) networking - 1 per node

### 2U 4-Node



(Rear View) SYS-220BT-H Series



#### **Highly Modular Multi-Node Systems with Tool-Less Design**

Supermicro ® X12 BigTwin ® systems provide superior performance and serviceability with dual 3rd Gen Intel Xeon Scalable processors per node and hot swappable toolless design.

Superior modular mid-plane design with PCI-E Next Gen Storage Controller Options.

Multi-node BigTwins with shared components can be more cost effective than standard 1U servers.

- HCI
- HPC
- CDN
- Hybrid Cloud, Container-as-a-Service
- Cloud Computing
- Big Data Analytics
- Back-up and recovery
- Scale-Out Storage

## **X12 ULTRA AND ULTRA-E**

### High Performance & Flexibility Enterprise Applications Rackmount System

Optimized for highest processor TDPs

Up to 22 hybrid NVMe

Up to 3 double width GPUs

PCI-E 4.0 support with 64 lanes per socket; Total 128 lanes

Dual 3rd Gen Intel® Xeon® Scalable processors up to 270W and 32 DIMM slots for maximum memory capacity

**2U Ultra-E**Optimized for 5G and Telco



SYS-220U-MTNR



#### **Highest Performance X12 Ultra and Ultra-E Servers**

Supermicro X12 Ultra system are designed to deliver the highest performance, flexibility, scalability and serviceability to demanding IT environments, and to power mission-critical Enterprise workloads, including support for 3rd Gen Intel Xeon Scalable processors.

Best-in-class server features including all NVMe, hybrid storage and low latency optimization.

Uncompromised performance design with 2 CPU sockets and 32 DIMMs optimized for supporting the highest processor TDPs.

Best-in-class server features including all NVMe, hybrid storage and low latency optimizations

- Enterprise Server
- Hyper-converged Storage
- Virtualization
- Al Training/Inferencing
- Big Data Analytic
- Cloud Computing
- CDN
- In-memory Database



### X12 CLOUDDC

### All-in-one Rackmount Platform for Cloud Data Centers

Tool-less design, configurable I/O and 16 DDR4-3200MHz DIMMs up to 4TB

Dual AIOM slots (OCP 3.0 compliant) for flexible networking plus 4-12 SATA/SAS drive bays with optional full NVMe support in selected SKUs

Highly versatile and compact 2U system that supports up to two double-width GPUs in a 25.5" (648 mm) chassis

Rich security features with TPMI 1.2/2.0, silicon root of trust, secured boot and Runtime FW Protection







SYS-620C-TN12R 12x 3.5"NVMe/SAS/SATA





## **Tool-less Mechanical Design for Rapid Cloud Deployment and Easy Maintenance**

Ultimate flexibility on I/O and storage with 2 or 4 PCI-E 4.0 x16 slots and dual AIOM slots (OCP 3.0 compliant) slots for maximum data throughput, X12 CloudDC is designed to have great serviceability with tool-less brackets, hot-swap drive trays and redundant power supplies that ensure a rapid deployment and more efficient maintenance in data centers.

Redundant high-efficiency Platinum/Titanium Level power supplies for resiliency and lower carbon footprint.

Rich Security Features: TPM 1.2/2.0, signed firmware, Silicon Root of Trust, Secure Boot, System Erase, Runtime FW protection, FIPS Compliance, Trusted Execution Environment.

- Cloud Computing
- Web Servers
- Hyper-converged Storage
- Virtualization
- File Servers
- Head-node Computing
- 5G Telco Al Inferencing

# X12 SUPERBLADE®

### Highest Density x86 Multi-Node Server for Enterprise Cloud, HPC Applications

#### **8U SuperBlade®**

SBE-820H/C/J/L-822/622/422

- Up to 20 hot-pluggable nodes in 8U
- Optimized for performance and advanced networking
- Integrated 200G HDR InfiniBand with non-blocking switch

#### **6U SuperBlade®**





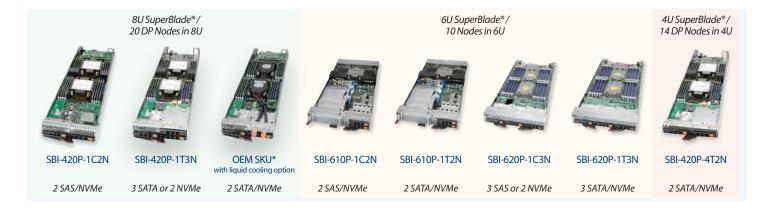
SBE-610J-822/622/422

- Up to 10 hot-pluggable nodes in 6U
- Performance and memory optimized architecture



SBE-414J-422/222

- Up to 14 hot-pluggable nodes in 4U
- · Optimized for performance, density and value



#### **Resource Saving Architecture**

A shared cooling, power and networking infrastructure is key to the high density and server efficiency offered by blade solutions. Supermicro's high performance, density optimized, and energy-efficient SuperBlade® can significantly reduce initial capital and operational expenses for many organizations.

In particular, Supermicro's new generation blade product portfolio has been designed to optimize the TCO of key components for today's data centers, such as free-air cooling, power efficiency, node density and networking management.

- HPC
- · Hybrid Cloud
- EDA
- Virtualization
- Health
- · Financial Services

<sup>\*</sup> Contact Supermicro for more information

# **X12 UNIVERSAL GPU**

### Multi-Architecture Flexibility, Future Proof Open-Standards Based Design

Dual socket Intel® Xeon® Scalable processors up to 270W

32 DIMM slots per node supporting DDR4-3200MHz and Intel® Optane™ 200-series persistent memory

Flexible storage configuration with 10 hot-swap 2.5" U.2 NVMe drives

4U chassis with optional 1U expansion module for improved thermal capacity (up to 700W GPUs) and 2x AlOMs for networking

Modular design for flexibility/future-proofing

Supports NVIDIA HGX® A100-4 GPUs

Optimized thermal capability for 500W/700W GPUs

#### **4U 4-GPU**



**5U 4-GPU** 



SYS-420GU-TNXR

#### Open, Modular, Standards Based Universal GPU System

Supermicro's Universal GPU System is the industry's most advanced and flexible GPU server platform. Designed to deliver maximum compute power for large-scale Al deep learning and HPC workloads, this modular, open-standards based platform supports the industry's most popular GPU technologies in a variety of form factors and combinations both today and into the future.

- AI/ML
- HPC

## X12 GPU WITH PCI-E

### High Performance and Flexibility for AI/ML and HPC Applications

High performance AI/ML and HPC-optimized solution

Optimized for graphics and rendering applications

Double the CPU to GPU throughput with PCI-E 4.0

Dual socket Intel® Xeon® Scalable processors up to 270W

**NVIDIA GPUs supported** 

**NVIDIA** certified system

**4U 10-GPU** 



SYS-420GP-TNR





SYS-120GQ-TNRT Highest Density, PCI-E GPU

2U 6-GPU



SYS-220GP-TNR Balanced Solution, PCI-E GPU

4U 4-GPU



SYS-740GP-TNRT Flexible Solution, PCI-E GPU

4U 10-GPU



SYS-420GP-TNR Dual Root Configuration, PCI-E GPU

#### Flexible Root Configuration, PCI-E GPU System

High density systems for double-width, full length PCI-E GPUs.

- 1U: support up to four PCI-E GPUs
- 2U: supporting up to six PCI-E GPUs
- 4U: supporting up to ten PCI-E GPUs

NVMe for lower latency with higher throughput.

New level of compute performance with Intel Xeon Scalable processors.

- AI/ML
- · Deep Learning Training and Inference
- High-performance Computing (HPC)
- · Rendering Platform for High-end **Professional Graphics**
- Best-in-Class VDI Infrastructure Platform

## X12 GPU WITH HGX

### High Performance and Flexibility for AI/ML and HPC Applications

### **4U HGX A100 8-GPU**

**Integrated Performance** 

Dense and scalable multi-GPU powerhouse supports the latest HGX A100 8 SXM4 GPUs

Next generation of NVIDIA NVLink™, with double the GPU-to-GPU direct bandwidth, almost 10X higher than PCI-E 4.0

New NVIDIA NVSwitch that is 2X faster than the previous generation

Networking up to 200G, GPUDirect RDMA and GPUDirect Storage

AIOM slot (OCP 3.0 compliant) support

**NVIDIA** certified system



SYS-420GP-TNAR(+)





Up to 640 GB Total GPU Memory



600 GB/s GPU-to-GPU Bi-directional Bandwidth

#### **Maximum Acceleration X12 GPU System**

With Supermicro's advanced architecture and thermal design, including liquid cooling and custom heatsinks, our 4U GPU system drive NVIDIA's latest HGX A100 8-GPU baseboard, can deliver up to 6x Al training performance and 7x inference workload capacity and highest density in a flexible 4U system.

Supermicro's unique AIOM slots (OCP 3.0 compliant) and a slew of PCI-E 4.0 slots of these systems enhance the multi-GPU communication and high-speed data flow between systems at a large scale.

The X12 GPU systems feature the latest technology stacks such as 200G networking, NVIDIA NVLink and NVSwitch, 1:1 GPUDirect RDMA, GPUDirect Storage, and NVMe-oF on InfiniBand.

- AI/ML
- Deep Learning Training and Inference
- High-performance Computing (HPC)
- Building Block for Scalable Al Infrastructure

## **X12 SUPERSTORAGE**

### Application-optimized High-Performance Storage Solution

New generation top-loading server optimized for field serviceability and field replacement

PCI-E 4.0 storage controller with hardware RAID and IT mode

Tool-less hot-swappable drive bays supporting 3.5 and 2.5" media

Flexible mix of hybrid HDD and SSD drive bays for best performance and TCO

Superior pullout drive drawer design

Hot swappable nodes, expanders, drives, power supplies and fans

#### **Adaptable Dense Storage Architectures for Cloud**





#### **Three Families of Storage Servers**

#### **Enterprise Optimized:**

- Open standards based x86 systems

#### **Cloud Density:**

- Highest density 3.5" servers with up to 90x HDDs and dual server nodes

#### **Petascale:**

- All Flash servers with up to 32 NVMe supporting U.2 and EDSFF form factor media

These powerful yet cost-effective systems provide excellent flexibility and value at entry-level price points. X12 server are optimized for data availability with a new drawer design and hot swappable drivers, power supplies and fans. Designed for ease of deployment maintenance with data center operations in mind.

#### **Key Applications**

- Object Storage
- Data Intensive HPC/AI
- Private & Hybrid Cloud
- Backup & Active Archive

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## **X12 MAINSTREAM**

### Versatile Entry Level and Volume Servers for Enterprise Applications

Highly versatile servers to enable a wide variety of enterprise server applications.

Choices of multiple form factors including rackmount and tower

A rich selection of storage and memory speed support

4 PCI-E 4.0 x16 and 2 PCI-E 4.0 x8 expansion slots

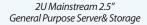
On-board networking options 2x 10G or 1x 1G Ethernet for networking

Dual 3rd Gen Intel® Xeon® Scalable processors up to 270W and 32 DIMMs slots for maximum memory capacity

# **4U/Tower**High Density Cloud Storage



SYS-740P-TR(T)





SYS-220P-C9R(T) 8x 2.5" SAS3, 8x 2.5" SATA3, 5x PCI-E slots

2U Mainstream 3.5" Entry Level, Cost Optimized Storage



SYS-620P-TR(T) 8x 3.5" SATA, 6x PCI-E slots

4U/Tower High Density Cloud Storage



SYS-740P-TR(T) 8x 3.5" SATA3, 6x PCI-E slots

#### **Mainstream Application Optimized**

The X12 Mainstream Application Optimized product family from Supermicro is a series of servers designed for entry level or volume selections. Enterprise IT managers can choose the exact model for their applications, with a precise set of integrated features needed for their applications.

These powerful yet cost-effective systems provide excellent flexibility and value at entry-level price points.

- SMB
- Virtualization
- Web Server
- · AI Inferencing
- Cloud Computing
- Head-node Computing

# **X12 HYPER-E AND HYPER**

### Best-in-class Performance and Flexibility Rackmount Server

High performance 1U & 2U systems with rear I/O and front I/O configurations to meet today's data center requirements

Dual 3rd Gen Intel® Xeon® Scalable processors up to 270W and 32 DIMM slots for maximum memory capacity

Lightning-fast storage with the latest generation PCI-E 4.0 NVMe SSDs and networking flexibility with AIOM (OCP 3.0 compliant) NIC support

Tool-less system design features intended to simplify field serviceability and lower maintenance time







SYS-220HE-FTNRD

AIOM Ready



SYS-220HE-FTNRD

6x 2.5" NVMe/SAS/SATA drives,
Short-Depth, Front I/O,
NEBS Level 3, DC -48V redundant
power (shown), AC also available.

2U Hyper-E Optimized for 5G and Telco



SYS-220HE-FTNR 6x 2.5" NVMe/SAS/SATA drives, Short-Depth, Front I/O, with DC power options

2U Hyper Optimized for Storage Performance



24x 2.5" NVMe/SAS/SATA drives

2U Hyper Optimized for Storage Capacity



SYS-620H-TN12R 12x 3.5" NVMe/SAS/SATA drives

1U Hyper Compute & Storage Powerhouse



SYS-120H-TNR 12x 2.5" NVMe/SAS/SATA drives

#### **Ultimate Configurability for Enterprise and Telco Applications**

The all-new Hyper series represents the latest generation of Supermicro rackmount servers built with the highest performance features to take on the most demanding workloads along with the storage & I/O flexibility that provide a custom fit to your application needs.

Telco optimized configurations include short depth, carrier grade (NEBS Level 3) Hyper-E servers with AC & DC power options.

Maintenance-friendly design innovations to eliminate the need for tools when servicing the system.

- 5G Core and Edge
- Telecom Micro Data Center
- Enterprise Server
- Cloud Computing
- Big Data Analytics
- Hyperconverged Storage
- Al Inference and Machine Learning
- · Network Function Virtualization

# X12 FATTWIN®

### Advanced Multi-node 4U Twin Architecture with 8 and 4 Nodes

# **4U 8-Node**Optimized for High Density Compute

Highly configurable 4U 8 node and 4 node systems

Front accessible service design for coldaisle serviceability

Hot-swappable drive bays – interchangeable NVMe, SAS or SATA

Better thermal with new optimized airflow designs for up to 165W processors

Dual 3rd Gen Intel® Xeon® Scalable processors up to 270W and 16 DIMM slots for maximum memory capacity



SYS-F610P2-RTN



SYS-F610P2-RTN





SYS-F620P3-RTBN

#### **Innovative Twin Architecture to Maximize Serviceability and Reliability**

The FatTwin® architecture provides flexibility and system accessibility for unique data center requirements.

Unique one-half width nodes provides for 2 nodes per rack unit, which allows for modularized left and right nodes with redundant power supplies for maximum reliability.

Highly modular multi-node systems with tool-less design.

Each node supports dual 3rd Gen Intel Xeon Scalable processors for improved performance.

- Hyperscale / Hyperconverged
- Cloud Optimized Servers
- Data Center Enterprise Applications
- Scale out of Storage expansion
- Telcom Data Center & ETSI certified
- Virtualization Server

# X12 TWINPRO®

### Cost-effective 2U Multi-node Platforms

4 DP Nodes in 2U

Dual socket supported. TDP up to 185W, 2 UPI

16 DIMM slots. Up to 4TB ECC RDIMM/ LRDIMM DDR4-3200MHz

Support up to 6 hot-swappable SAS/SATA and 2 internal M.2 NVMe SSDs per node

Onboard dual 10GbE RJ45 ports with Intel® X710-AT2 controller

2 PCI-E 4.0 x16 LP expansion slots and 1 PCI-E 4.0 x8 (M.2)

2 Redundant 2200W Titanium Level (96%) power supplies







SYS-220TP-HTTR / HCOTR / HC1TR 6x 2.5" SAS/SATA and 2x M.2 NVMe drive bays per node

#### 2U 4-Node



SYS-620TP-HTTR / HCOTR / HC1TR
3x 3.5" SAS/SATA and 2x M.2 NVMe drive bays per node

#### **Cost-Effective 2U 4-Node Rackmount Server**

TwinPro® systems are designed for simplified deployment and maintenance, and assembled with the highest quality to ensure continuous operation even at maximum capacity.

Optimized thermal design for maximum power efficiency.

- Enterprise Mission-critical Applications
- Data Center Cloud Computing
- HPC
- Virtualization
- Big Data
- Financial Analysis



# X12 SUPEREDGE

### High-Density Computing and Flexibility at the Intelligent Edge

2U Short-depth, 3-Node System

Single 3rd Gen Intel® Xeon® Scalable processor per node

8 DIMMs per node, 8TB DRAM or 12TB DRAM with Intel® Optane™ PMem)

3 PCI-E 4.0 x16 slots per node

Operating temperatures from -5°C to 55°C

#### 2U, Short-depth, 3-Node



SYS-210SE-31A

2U, Short-depth, 3-Node, AC



SYS-210SE-31A

3rd Gen Intel \* Xeon\* Scalable processor
with 2000W redundant AC power supply

2U, Short-depth, 3-Node, DC



#### SYS-210SE-31D

3rd Gen Intel \* Xeon\* Scalable processor with 2000W redundant DC power supply

#### Data Center Class Performance and Expandability at the Edge

Supermicro's SuperEdge is designed to handle increasing compute and I/O density requirements of modern edge applications. With 3 customizable nodes, each outfitted with a 3rd Gen Intel Xeon Scalable Processor, SuperEdge delivers high-class performance in a 2U, short-depth form factor. Each node is hot-swappable and offers front access I/O, making the system ideal for remote IoT, Edge, or Telco deployments.

- Telecom
- ORAN
- IoT/Intelligent Edge

# X12 MP 4-WAY SERVER

### Highest Performance and Flexibility for Enterprise Applications

Large memory footprint for up to 18TB

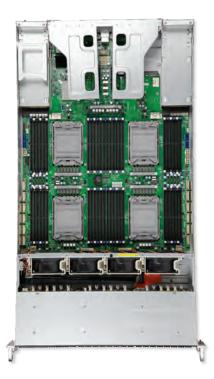
All hybrid hot-swappable drive bay - NVMe, SAS, or SATA

Supports 3rd Gen Intel® Xeon® Scalable (Cooper Lake) processors

Support for PCI-E 3.0 for network interface cards

SAP HANA Certified System – SAP HANA 1.0 SPS 12, SAP HANA 2.0





SYS-240P-TNRT 24x 2.5" NVMe/SAS3/SATA3 drive bays, 48 DIMM slots, up to 18TB

#### **Highest Performance and Flexibility**

New levels of compute performance and flexibility with support of 3rd Gen Intel® Xeon® Scalable processors.

Dynamic storage with platforms that support direct-attached full-hybrid all NVMe for lower latency with higher throughput and IOPS up to 24x 2.5" hybrid NVMe/SAS3/SATA3 drive bays.

Flexible on-board network with up to dual 10GBase-T and dual SFP+ ports allows for cost-effective solutions for data communications.

#### **Key Applications**

- Artificial Intelligence (AI)
- Business Intelligence
- ERP
- CRM
- Scientific Virtualization
- In-Memory Database
- HCI
- SAP HANA

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# **X12 SUPERWORKSTATIONS**

### Workstations for High Performance Workloads

Mid-tower and 4U tower with support for 3rd Gen Intel® Xeon® Scalable processors

Mid-tower with up to 4 internal 3.5" SATA drives and 2 onboard M.2 slots, optional 4x 2.5" drive carrier (for total of 8 drives) and optional NVMe drive support

4U tower with 8 hot-swappable 3.5"/2.5" SATA drive bays and 2 onboard M2 slots, optional SAS and NVMe drive support.

#### **4U Tower**



SYS-740A-T 8x 3.5"/2.5" SATA drives

#### **Mid-Tower Compact Powerhouse**



SYS-730A-i 4x 3.5" drives

#### Server-grade workstations for high-performance workloads

Supermicro's SuperWorkstations are optimized for applications requiring powerful compute and graphics capabilities.

Supporting the latest Intel® Xeon® Scalable processors and multiple NVIDIA GPUs to boost productivity and creativity for professional artists, designers, and engineers across industries such as manufacturing, media and entertainment, and energy.

Available server-grade features include hot-swap storage bays, IPMI, and redundant Titanium-level power supplies.

- Rendering
- CAD
- Multimedia Digital Content Creation
- Engineering/Scientific Research

## **X12 WIO**

### Industry's Widest Variety of I/O Optimized Servers

Cost-effective systems supporting up to 6 PCI-E 4.0 devices

Hot-swappable 2.5" or 3.5" SATA3 storage

Onboard networking dual 10 Gigabit Ethernet

Up to 4 NVMe hybrid storage supported optionally

3rd Gen Intel® Xeon® Scalable processors up to 270W and 8 DIMM slots for maximum memory capacity

#### **2U UP WIO**



2U UP WIO



SYS-520P-WTR 2U 8x 3.5" SATA / option for 2 NVMe drives / Redundant power

1U UP WIO



SYS-110P-WTR 1U 10x 2.5" SATA / option for NVMe drives

1U UP WIO



SYS-510P-WT 1U 4x 3.5" SATA / option for 4 NVMe drives

1U UP WIO



SYS-510P-WTR 1U 4x 3.5" SATA / option for 4 NVMe drives / Redundant power

#### Supermicro WIO SuperServer®

Supermicro WIO systems offer a wide range of I/O options to deliver truly optimized systems for specific requirements. Users can optimize the storage and networking alternatives to accelerate performance, increase efficiency and find the perfect fit for their applications.

In addition to enabling customizable configurations and optimization for multiple application requirements, Supermicro WIO SuperServers® also provide attractive cost advantages and investment protection.

- Enterprise Applications
- · Networking Appliance
- Firewall / Security Appliances
- General Purpose Computing
- Cloud Computing
- Media Entertainment



## X12 IOT/EMBEDDED

High-efficiency, High-performance Portfolio with Compact Form Factors and Long Life Cycle

High-density processing power at the edge

Connecting the intelligent world from devices to the cloud

Low-power high-efficiency computing

Long life cycle

Compact form factors

**UP Short-Depth, Front I/O** 



2U Compact



SYS-210P-FRDN6T Ultra short depth, 2U Front I/O, 2x 2.5" drives 1U Embedded



SYS-110P-FDWTR
1U Front I/O,
Front DC PSU,
2x Internal 2.5" drives,
2 PCI-E 4.0 x16 FHFL, 1 PCIe 4.0 x16 LP

1U Embedded



SYS-110P-FRDN2T 1U Front I/O, Rear DC PSU, 2x Internal 2.5" drives, 2 PCI-E 4.0 x16 FHFL 1U Embedded



SYS-110P-FRN2T 1U Front I/O, Rear AC PSU 2x Internal 2.5" drives 2 PCI-E 4.0 x16 FHFL

# **Expanding our Product Portfolio to address 5G, Edge Computing, and Emerging IoT Systems**

Supermicro provides innovative and first-to-market technologies that are the building blocks for today's embedded computing platforms. Rapid growth in embedded markets and open standards are driving the need for higher levels of product integration and optimization through virtualization, Al inferencing, network connectivity, remote management, mobile communication, expanded I/O, and device-to-device communications using space and power efficient configurations.

Supermicro's family of high-performance embedded products are optimized for a wide range of applications and solutions.

Supermicro offers many flexible and customized solutions for critical OEM projects, as well as advanced designs for stringent environments, firmware customization, BOM enhancements, and a wide range of legacy IO support.

- Cloud Computing
- 5G Core and Edge
- Network Function Virtualization

# **SYSTEM MANAGEMENT SOFTWARE**

### Leverage Supermicro's Management Software Suite to Meet Your IT Infrastructure Challenges

With a comprehensive range of high-end software solutions, Supermicro gives IT administrators the tools to optimize the management of IT systems and increase the utilization of computing and storage infrastructure. Whether you are looking to manage individual systems, optimize server lifecycle processes, or streamline operations for an entire data center, Supermicro has the right software to help you accomplish your goals.



- · Obtain valuable insights in your infrastructure
- · Monitor the health of servers and critical components
- · Get proactive alerts



- · Maintain system uptime to meet SLAs
- Early symptom detection to prevent component failure
- · Remote management and troubleshooting



- · Protect your IT infrastructure from external threats
- · Centralized patch and BIOS management
- · Extensive security features

### System Management Software Suite Bundles

Supermicro's System Management Software Suite consists of a set of specialized applications. These are available in the following bundles.

<b>Suite Bundle</b>	Standard	Basic	Advanced	Enterprise
Description	Covers all core functionality to effectively set up, manage, and monitor your Supermicro systems. These features are available to all Supermicro users.	Extends the core functionality and makes system management easier with additional features, such as remote BIOS management and system updates.	Delivers a broad set of tools to help administrators improve the performance, up-time, and monitoring of Supermicro systems.	Offers an extensive platform to manage large data centers and coordinate automated lifecycle management, software-defined infrastructure, and more in a single pane of glass.
License	No license required	• SFT-OOB-LIC	SFT-DCMS-SINGLE	<ul><li>SFT-DCMS-SINGLE +</li><li>SFT-SDDC-SINGLE</li></ul>
Key Features <sup>*</sup>	<ul> <li>Secure remote console (KVM/HTML5)</li> <li>System temperature monitoring</li> <li>System power thresholds &amp; alerts</li> <li>Component monitoring</li> <li>Email alerting</li> <li>Remote configuration</li> <li>Offline diagnostics</li> <li>Crash dump</li> <li>License management</li> </ul>	<ul> <li>Remote BMC management</li> <li>Remote BIOS management</li> <li>Out-of-Band systems checks</li> <li>TPM Provisioning</li> <li>Mount/Unmount ISO images from Samba/HTTP</li> <li>Basic Redfish APIs</li> <li>CIM management</li> <li>SysLog</li> </ul>	<ul> <li>Remote OS deployment</li> <li>Auto-discovery</li> <li>Power capping</li> <li>RAID monitoring and configuration</li> <li>HDD monitoring</li> <li>Advanced Redfish APIs</li> <li>FW update policy</li> <li>System lock down</li> <li>Crash screen/video capture</li> </ul>	<ul> <li>3rd Party vendor support</li> <li>POD &amp; Rack-level management</li> <li>SDI Lifecycle management</li> <li>Manage Composable Dissagregated Infrastructure</li> <li>Zero-touch provisioning for network configuration</li> <li>Single pane of glass for data center deployment</li> <li>Rich analytics &amp; telemetry</li> <li>User defined role-based access control</li> </ul>

<sup>\*</sup> For detailed information, please check with your Supermicro sales representative or refer to Supermicro website: https://www.supermicro.com/en/solutions/management-software



# **X12 AIOM NETWORKING**

# New Supermicro Advanced I/O Module (AIOM) Cards Provide I/O Flexibility with OCP Superset

#### Optimized Shared Resources for up to 50% Reduction in Power and Cooling TCO



Model	AOC-AG-i4SM	AOC-AG-i2M	AOC-AG-i4M	AOC-ATG-i2TM	AOC-ATG-i2SM	AOC-ATG-i4SM
Description	Quad-Port GbE	Dual-Port GbE	Quad-Port GbE	Dual-Port 10GbE	Dual-Port 10GbE	Quad-Port 10GbE
Port	4x SFP	2xRJ45	4xRJ45	2x RJ45	2x SFP+	4x SFP+
Speed	1Gbps	1Gbps	1Gbps	10Gbps	10Gbps	10Gbps
Controller	Intel® i350-AM4	Intel® i350-AM2	Intel® i350-AM4	Intel® X550-AT2	Intel® X710-BM2	Intel® XL710-BM1
PCI-E	PCI-E 2.1 x4	PCI-E 2.1 x4	PCI-E 2.1 x4	PCI-E 3.0 x4	PCI-E 3.0 x8	PCI-E 3.0 x8
Power	4.4W	3.7W	4.4W	13W	6.2W	7W
Status	Released	Released	Released	Released	Q2 2021	Q2 2021



Model	AOC-ATG- i2T2SM	AOC-ATGC- i2TM	AOC-A25G- b2SM	AOC-AH25G- m2S2TM	AOC-A25G- m2SM	AOC-A100G- b2CM	AOC-A100G- m2CM
Description	Quad-Port 10GbE	Dual-Port 10GbE	Dual-Port 25GbE	2-Port25GbE & 2-Port 10GbE	Dual-Port 25GbE	Dual-Port 100GbE	Dual-Port 100GbE
Port	2x RJ45 2x SFP+	2x RJ45	2x SFP28	2x SFP28 2x RJ45	2x SFP28	2x QSFP28	2x QSFP28
Speed	10Gbps	10Gbps	25Gbps	25Gbps / 10Gbps	25Gbps	100Gbps	100Gbps
Controller	Intel® X710-TM4	Intel® X710-AT2	Broadcom® BCM57414	Mellanox <sup>®</sup> ConnectX-4 Lx EN Intel <sup>®</sup> X550-AT2	Mellanox®CX-6 LX	Broadcom® BCM57508	Mellanox® ConnectX-6 DX
PCI-E	PCI-E 3.0 x8	PCI-E 3.0 x8	PCI-E 3.0 x8	PCI-E 3.0 x8 PCI-E 3.0 x4	PCI-E 4.0/3.0 x8	PCI-E 4.0 x16	PCI-E 4.0 x16
Power	10W	10W	7.7W	25W	12.5W	20W	20W
Status	Released	Q2 2021	Released	Released	Q2 2021	Q2 2021	Q2 2021

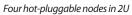














MODEL	SYS-210GT-HNTF	SYS-210GT-HNC8F
Processor Support	3rd Gen Intel® Xeon® Scalable processors. Single Socket LGA 4189 (Socket P+) supported; TDP up to 270W	3rd Gen Intel® Xeon® Scalable processors. Single Socket LGA 4189 (Socket P+) supported; TDP up to 270W
Key Applications	<ul> <li>Mission Critical Web Applications</li> <li>EDA (Electric Design Automation)</li> <li>Telco Edge Cloud</li> <li>High-availability Cache Cluster</li> <li>Multi-Purpose CDN</li> </ul>	<ul> <li>HPC</li> <li>High-availability Cache Cluster</li> <li>Multi-Purpose CDN</li> <li>MEC (Multi-Access Edge Computing)</li> <li>Cloud Gaming</li> </ul>
Outstanding Features	<ul> <li>Four hot-pluggable systems (nodes) in a 2U form factor</li> <li>Single-Socket, 3rd Gen Intel® Xeon® Scalable processors up to 270W TDP</li> <li>Up to 16 DIMM Slots or 4TB (with Intel® Optane™ Persistent Memory support)</li> <li>Optional: AIOM PCI-E 4.0 x16 LP (OCP 3.0 compliant)</li> <li>Integrated GrandTwin® I/O Module with BMC, 2x USB, VGA and 2x 10GbE or 2x 25GbE</li> <li>Up to 4 Hot-swap 2.5" NVMe/SATA drives per node</li> <li>2x cooling fans per 2U enclosure, 16.5K RPM Heavy Duty; Shared Cooling Design</li> <li>2200W Redundant Power Supplies Titanium Level (96%+); Shared Power Design</li> </ul>	<ul> <li>Four hot-pluggable systems (nodes) in a 2U form factor</li> <li>Single-Socket, 3rd Gen Intel® Xeon® Scalable processors up to 270W TDP</li> <li>Up to 16 DIMM Slots or 4TB (with Intel® Optane™ Persistent Memory support)</li> <li>Optional: AIOM PCI-E 4.0 x16 LP (OCP 3.0 compliant)</li> <li>Integrated GrandTwin® I/O Module with BMC, 2x USB, VGA and 2x 10GbE or 2x 25GbE</li> <li>Up to 4 Hot-swap 2.5" SAS/SATA drives per node</li> <li>2x cooling fans per 2U enclosure, 16.5K RPM Heavy Duty; Shared Cooling Design</li> <li>2200W Redundant Power Supplies Titanium Level (96%+); Shared Power Design</li> <li>Built-in SAS3 Support via Broadcom 3808; IT Mode</li> </ul>
Serverboard	SUPER●® X12SPT-G	SUPER●® X12SPT-GC
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory
Expansion Slots	PCI-E 4.0 x16 LP slot(s)	PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA Broadcom® 3808
Connectivity	via AIOM	via AlOM
VGA/Audio	1 onboard VGA port	1 onboard VGA port
Management	Supermicro Server Mgmt (Redfish® API), Supermicro Intelligent Mgmt (BMC Resources), Supermicro IPMI Utilities, Supermicro Diagnostics Offline (SDO), Supermicro Thin-Agent Service (TAS), SuperDoctor® 5 (SD5), SPM, SUM, SSM, SuperCloud Composer	Supermicro Server Mgmt (Redfish® API), Supermicro Intelligent Mgmt (BMC Resources), Supermicro IPMI Utilities, Supermicro Diagnostics Offline (SDO), Supermicro Thin-Agent Service (TAS), SuperDoctor® 5 (SD5), SPM, SUM, SSM, SuperCloud Composer
Drive Bays	4x 2.5" hot-swap NVMe/SATA drive bays; 4x 2.5" NVMe dedicated; Optional RAID support via Intel® PCH	4x 2.5" hot-swap NVMe/SATA/SAS drive bays; 4x 2.5" NVMe dedicated; Optional RAID support via Broadcom® 3808 AOC
Peripheral Bays	None	None
Power Supply	Redundant 2200W Titanium level (96%)	Redundant 2200W Titanium level (96%)
Cooling System	2x 8cm heavy duty fan(s)	2x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 449 x 88 x 711.2mm (17.67" x 3.46" x 28") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	2U Rackmount Enclosure: 449 x 88 x 711.2mm (17.67" x 3.46" x 28") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")



3rd Gen Intel® Xeon® Scalable processors Supported



6x 2.5" drives/node x 4 Nodes



6x 2.5" drives/node x 4 Nodes



6x 2.5" drives/node x 4 Nodes



MODEL	SYS-220BT-HNC8R	SYS-220BT-HNC9R	SYS-220BT-HNTR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 205W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 205W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 205W;
Key Applications	<ul> <li>All-Flash Hyperconverged Infrastructure</li> <li>Diskless HPC Clusters</li> <li>Container-as-a-Service; Application Accelerator</li> </ul>	<ul><li>High-Density Storage RAID Array</li><li>Virtualized Big Data Analytics</li><li>Mission Critical HPC</li></ul>	<ul> <li>Diskless HPC Clusters</li> <li>High-Performance File System</li> <li>Container-as-a-Service; Application Accelerator</li> <li>All-Flash NVMe Hyperconverged Infrastructure</li> </ul>
Outstanding Features	<ul> <li>Up to 2 Nvidia T4 GPU support, with limited CPU selection</li> <li>Tool-less support for swapping AOC cards</li> <li>Supports NVMe/SATA/SAS storage devices</li> <li>Liquid Cooling Support</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>4 Hot-Swap Nodes in 2U, Shared Power and Cooling Design</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>	<ul> <li>Tool-less support for swapping AOC cards</li> <li>Supports NVMe/SATA/SAS storage devices</li> <li>Liquid Cooling Support</li> <li>HW RAID Support for Hot-Swappable SAS/SATA Drives</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>4 Hot-Swap Nodes in 2U, Shared Power and Cooling Design</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>	<ul> <li>Up to 2 Nvidia T4 GPU support, with limited CPU selection</li> <li>Tool-less support for swapping AOC cards</li> <li>Liquid Cooling Support</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>4 Hot-Swap Nodes in 2U, Shared Power and Cooling Design</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>
Serverboard	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory
Expansion Slots	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA Broadcom® 3808	Intel® SATA Broadcom® 3908	Intel® SATA
Connectivity	via AIOM	via AIOM	via AIOM
VGA/Audio	1 onboard VGA port	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog
Drive Bays	6x 2.5" hot-swap NVMe/SATA/SAS drive bays; 6x 2.5" NVMe hybrid; Optional HBA support via SAS3808 Adapter	6x 2.5" hot-swap NVMe/SATA/SAS drive bays; 6x 2.5" NVMe hybrid; Optional RAID support via Broadcom® 3908 AOC	6x 2.5" hot-swap NVMe/SATA drive bays; 6x 2.5" NVMe hybrid; Optional RAID support via Intel® PCH
Peripheral Bays	None	None	None
Power Supply	Redundant 2600W Titanium level (96%)	Redundant 2600W Titanium level (96%)	Redundant 2600W Titanium level (96%)
Cooling System	4x 16.5K RPM Heavy Duty 8cm Fan(s)	4x 16.5K RPM Heavy Duty 8cm Fan(s)	4x 16.5K RPM Heavy Duty 8cm Fan(s)
Form Factor	2U Rackmount Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	2U Rackmount Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	2U Rackmount Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")



3rd Gen Intel® Xeon® Scalable processors Supported



3x 3.5" drives/node x 4 Nodes

3x 3.5" drives/node x 4 Nodes



12x 2.5" drives/node x 2 Nodes



MODEL	SYS-620BT-HNC8R	SYS-620BT-HNTR	SYS-220BT-DNC8R
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Container Storage</li><li>Scale-Out File Storage</li><li>Hyperconverged Infrastructure</li></ul>	<ul><li>Scale-Out File Server</li><li>Container Storage</li><li>Hyperconverged Infrastructure</li></ul>	<ul> <li>All-Flash Object Storage</li> <li>All-Flash Storage Area Network</li> <li>All-Flash Hyperconverged Infrastructure</li> </ul>
Outstanding Features	<ul> <li>Tool-less support for swapping AOC cards</li> <li>Supports NVMe/SATA/SAS storage devices</li> <li>Liquid Cooling Support</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>4 Hot-Swap Nodes in 2U, Shared Power and Cooling Design</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>	Tool-less support for swapping AOC cards Liquid Cooling Support HW Boot Controller for NVMe M.2 drives Hot-Swap Nodes in 2U, Shared Power and Cooling Design 20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)  1 AIOM card support (PCI-E 4.0)	Tool-less support for swapping AOC cards Supports NVMe/SATA/SAS storage devices Liquid Cooling Support HW Boot Controller for NVMe M.2 drives Balanced IO performance for up to 12 NVMe Gen4 drives 20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory) Het-Swap Nodes in 2U, Shared Power and Dedicated Cooling Per Node 1 AIOM card support (PCI-E 4.0)
Serverboard	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory
Expansion Slots	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s) PCI-E 4.0 x8 LP slot(s)
Onboard Storage Controller	Intel® SATA Broadcom® 3808	Intel® SATA	Intel® SATA Broadcom® 3816
Connectivity	via AIOM	via AIOM	via AIOM
VGA/Audio	1 onboard VGA port	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog
Drive Bays	3x 3.5" hot-swap NVMe/SATA/SAS drive bays; 3x 3.5" NVMe hybrid; 3x 2.5" NVMe hybrid; Optional HBA support via SAS3808 Adapter	3x 3.5" hot-swap NVMe/SATA drive bays; 3x 3.5" NVMe hybrid; 3x 2.5" NVMe hybrid; Optional RAID support via Intel® PCH	12x 2.5" hot-swap NVMe/SATA/SAS drive bays; 12x 2.5" NVMe hybrid; Optional HBA support via SAS3816 AOC
Peripheral Bays	None	None	None
Power Supply	Redundant 2600W Titanium level (96%)	Redundant 2600W Titanium level (96%)	Redundant 2200W Titanium level (96%)
Cooling System	4x 14.9K RPM Heavy Duty 8cm Fan(s)	4x 14.9K RPM Heavy Duty 8cm Fan(s)	4x 16.5K RPM Heavy Duty 8cm Fan(s)
Form Factor	• 2U Rackmount • Enclosure: 449 x 88 x 774mm (17.68" x 3.47" x 30.5") • Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	• 2U Rackmount • Enclosure: 449 x 88 x 774mm (17.68" x 3.47" x 30.5") • Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	<ul> <li>2U Rackmount</li> <li>Enclosure: 449 x 88 x 730mm</li> <li>(17.68" x 3.47" x 28.75")</li> <li>Package: 626 x 248 x 1150mm</li> <li>(24.65" x 9.76" x 45.28")</li> </ul>



3rd Gen Intel® Xeon® Scalable processors Supported



12x 2.5" Drives/Node x 2 Nodes







#### 6x 3.5" Drives/Node x 2 Nodes



Salvan yani Sala			
MODEL	SYS-220BT-DNTR	SYS-620BT-DNTR	SYS-620BT-DNC8R
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 270W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 250W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 250W;
Key Applications	<ul> <li>Big Data Analytics and Al</li> <li>Scale Out All-Flash NVMe Storage</li> <li>Diskless HPC Clusters</li> <li>High-Performance File System</li> </ul>	<ul><li>Back-up &amp; Recovery</li><li>Scale-Out Object Storage</li><li>Hyperconverged Infrastructure</li></ul>	<ul><li>Back-up &amp; Recovery</li><li>Scale-Out Object Storage</li><li>Hyperconverged Infrastructure</li></ul>
Outstanding Features	Up to 2 Nvidia T4 GPU support, with limited CPU selection     Tool-less support for swapping AOC cards     Supports NVMe/SATA/SAS storage devices     Liquid Cooling Support     HW Boot Controller for NVMe M.2 drives     Balanced IO performance for up to 12 NVMe Gen4 drives     20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)     2 Hot-Swap Nodes in 2U, Shared Power and Dedicated Cooling Per Node     1 AIOM card support (PCI-E 4.0)	<ul> <li>Tool-less support for swapping AOC cards</li> <li>Liquid Cooling Support</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>2 Hot-Swap Nodes in 2U, Shared Power and Dedicated Cooling Per Node</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>	<ul> <li>Tool-less support for swapping AOC cards</li> <li>Liquid Cooling Support</li> <li>HW Boot Controller for NVMe M.2 drives</li> <li>20 Memory slots (16 DIMM + 4 Intel® Optane™ Persistent Memory)</li> <li>2 Hot-Swap Nodes in 2U, Shared Power and Dedicated Cooling Per Node</li> <li>1 AIOM card support (PCI-E 4.0)</li> </ul>
Serverboard	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6	SUPER●® X12DPT-B6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory	16 DIMM slots (16 DRAM + 4 PMem) Up to 4TB: 16x 256GB DRAM Up to 6TB: 8x 256GB DRAM and 8x 512GB Intel® Optane™ Persistent Memory
Expansion Slots	M.2 slot(s) PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® SATA Broadcom® 3808
Connectivity	via AIOM	via AIOM	via AIOM
VGA/Audio	1 onboard VGA port	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; Supemicro Out of Band (OOB) License; SuperCloud Composer; SuperDoctor® 5; Watch Dog
Drive Bays	12x 2.5" hot-swap NVMe/SATA drive bays; 12x 2.5" NVMe hybrid; Optional RAID support via Intel® PCH	6x 3.5" hot-swap NVMe/SATA drive bays; 6x 3.5" NVMe hybrid; 6x 2.5" NVMe hybrid; Optional RAID support via Intel® PCH	6x 3.5" hot-swap NVMe/SATA/SAS drive bays; 6x 3.5" NVMe hybrid; 6x 2.5" NVMe hybrid; Optional HBA support via SAS3808 Adapter
Peripheral Bays	None	None	None
Power Supply	Redundant 2200W Titanium level (96%)	Redundant 2200W Titanium level (96%)	Redundant 2200W Titanium level (96%)
Cooling System	4x 16.5K RPM Heavy Duty 8cm Fan(s)	4x 14.9K RPM Heavy Duty 8cm Fan(s)	4x 14.9K RPM Heavy Duty 8cm Fan(s)
Form Factor	2U Rackmount Enclosure: 449 x 88 x 730mm (17.68" x 3.47" x 28.75") Package: 626 x 248 x 1150mm (24.65" x 9.76"	2U Rackmount Enclosure: 449 x 88 x 774mm (17.68" x 3.47" x 30.5") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")	2U Rackmount Enclosure: 449 x 88 x 774mm (17.68" x 3.47" x 30.5") Package: 626 x 248 x 1150mm (24.65" x 9.76" x 45.28")

x 45.28")

x 45.28")

x 45.28")













MODEL	SYS-220U-MTNR	SYS-620U-TNR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>HPC</li> <li>Virtualization</li> <li>5G/Telco</li> <li>Application Tier Service Provider</li> <li>Software Defined Storage</li> <li>High End Enterprise Server</li> <li>Cloud Computing</li> </ul>	<ul> <li>HPC</li> <li>Virtualization</li> <li>5G/Telco</li> <li>Application Tier Service Provider</li> <li>Software Defined Storage</li> <li>High End Enterprise Server</li> <li>Cloud Computing</li> </ul>
Outstanding Features	<ul> <li>Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM)</li> <li>Short-depth model (22.6") optimized for 5G and Telco Markets</li> <li>Optimized cooling with support up to 270W TDP processors</li> <li>Modular Components for Building Application-Optimized Solutions</li> <li>Hot-swappable hybrid drive bays supporting NVMe, SATA or SAS</li> <li>Flexible onboard networking options</li> <li>Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors</li> <li>Configurable number of PCI-E 4.0 expansion slots with support for double-width GPUs and FPGAs.</li> </ul>	<ul> <li>Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM)</li> <li>Optimized cooling with support up to 270W TDP processors</li> <li>Modular Components for Building Application-Optimized Solutions</li> <li>Hot-swappable hybrid drive bays supporting NVMe, SATA or SAS</li> <li>Flexible onboard networking options</li> <li>Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors</li> <li>Configurable number of PCI-E 4.0 expansion slots with support for double-width GPUs and FPGAs.</li> </ul>
Serverboard	SUPER●® X12DPU-6	SUPER® X12DPU-6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)		
Expansion Slots	1 PCI-E 4.0 x16 FH, 10.5"L slot 1 PCI-E 4.0 x16 LP slot 5 PCI-E 4.0 x8 FH, 10.5"L slots (PCI-E 4.0 x16 options available) 1 PCI-E 4.0 x8 internal LP slot	1 PCI-E 4.0 x16 FH, 10.5"L slot 1 PCI-E 4.0 x16 LP slot 5 PCI-E 4.0 x8 FH, 10.5"L slots (PCI-E 4.0 x16 options available) 1 PCI-E 4.0 x8 internal LP slot
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 and 2x 10GbE SFP+ with Intel® X710-TM4 (optional) 2x 10GbE RJ45 with Intel® X710-AT2 (optional)	2x 10GbE RJ45 and 2x 10GbE SFP+ with Intel® X710-TM4 (optional) 2x 10GbE RJ45 with Intel® X710-AT2 (optional)
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) License; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) License; Watch Dog
Drive Bays	6x 2.5" hot-swap NVMe/SATA/SAS drive bays; 6x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC	12x 3.5" hot-swap NVMe/SATA/SAS drive bays; 12x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC
Peripheral Bays	None	None
Power Supply	Redundant 1600W Titanium level (96%)	Redundant 1200W Titanium level (96%)
Cooling System	6x 6cm heavy duty fan(s)	4x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 437 x 89 x 574mm (17.2" x 3.5" x 22.6") Package: 625 x 253 x 1154mm (24.6" x 9.96" x 45.43")	2U Rackmount Enclosure: 437 x 89 x 737.9mm (17.2" x 3.5" x 29.05") Package: 605 x 256 x 947mm (23.81" x 10.07" x 37.28")







12x 2.5" Drives





24x 2.5" Drives

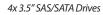


MODEL	SYS-120U-TNR	SYS-610U-TNR	SYS-220U-TNR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>HPC</li> <li>Virtualization</li> <li>5G/Telco</li> <li>Application Tier Service Provider</li> <li>Software Defined Storage</li> <li>High End Enterprise Server</li> <li>Cloud Computing</li> </ul>	<ul> <li>HPC</li> <li>Virtualization</li> <li>5G/Telco</li> <li>Application Tier Service Provider</li> <li>Software Defined Storage</li> <li>High End Enterprise Server</li> <li>Cloud Computing</li> </ul>	<ul> <li>HPC</li> <li>Virtualization</li> <li>5G/Telco</li> <li>Application Tier Service Provider</li> <li>Software Defined Storage</li> <li>High End Enterprise Server</li> <li>Cloud Computing</li> </ul>
Outstanding Features	<ul> <li>Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM)</li> <li>Optimized cooling with support up to 270W TDP processors</li> <li>Modular Components for Building Application-Optimized Solutions</li> <li>Hot-swappable hybrid drive bays supporting NVMe, SATA or SAS</li> <li>Flexible onboard networking options</li> <li>Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors</li> </ul>	<ul> <li>Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM)</li> <li>Optimized cooling with support up to 270W TDP processors</li> <li>Modular Components for Building Application-Optimized Solutions</li> <li>Hot-swappable hybrid drive bays supporting NVMe, SATA or SAS</li> <li>Flexible onboard networking options</li> <li>Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors</li> <li>Configurable number of PCI-E 4.0 expansion</li> </ul>	<ul> <li>Up to 8TB Intel® Optane™ Persistent Memory (up to 12TB with DRAM)</li> <li>Optimized cooling with support up to 270W TDP processors</li> <li>Modular Components for Building Application-Optimized Solutions</li> <li>Hot-swappable hybrid drive bays supporting NVMe, SATA or SAS</li> <li>Flexible onboard networking options</li> <li>Dual Socket P+ (LGA-4189) 3rd Gen Intel® Xeon® Scalable Processors</li> <li>Configurable number of PCI-E 4.0 expansion</li> </ul>
Serverboard	SUPER●® X12DPU-6	SUPER●® X12DPU-6	SUPER●® X12DPU-6
Chipset System Memory (Max.)	Intel® C621A	Intel® C621A	Intel® C621A
Expansion Slots	2 PCI-E 4.0 x16 FH, 10.5"L slots 1 PCI-E 4.0 x16 LP slot 1 PCI-E 4.0 x16 Internal LP slot	2 PCI-E 4.0 x16 FH, 10.5″L slots 1 PCI-E 4.0 x16 LP slot 1 PCI-E 4.0 x16 Internal LP slot	1 PCI-E 4.0 x16 FH, 10.5"L slot 1 PCI-E 4.0 x16 LP slot 5 PCI-E 4.0 x8 FH, 10.5"L slots (PCI-E 4.0 x16 options available) 1 PCI-E 4.0 x8 internal LP slot
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 and 2x 10GbE SFP+ with Intel® X710-TM4 (optional) 2x 10GbE RJ45 with Intel® X710-AT2 (optional)	2x 10GbE RJ45 and 2x 10GbE SFP+ with Intel® X710-TM4 (optional) 2x 10GbE RJ45 with Intel® X710-AT2 (optional)	2x 10GbE RJ45 and 2x 10GbE SFP+ with Intel® X710-TM4 (optional) 2x 10GbE RJ45 with Intel® X710-AT2 (optional)
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) License; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) License; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) License; Watch Dog
Drive Bays	12x 2.5" hot-swap NVMe/SATA/SAS drive bays; 12x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC	4x 3.5" hot-swap NVMe/SATA/SAS drive bays; 4x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC	24x 2.5" hot-swap NVMe/SATA/SAS drive bays; 22x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC
Peripheral Bays	None	None	None
Power Supply	Redundant 1200W Titanium level (96%)	Redundant 1200W Titanium level (96%)	Redundant 1600W Titanium level (96%)
Cooling System	8x 4cm heavy duty fan(s)	8x 4cm heavy duty fan(s)	4x 8cm heavy duty fan(s)
Form Factor	1U Rackmount Enclosure: 437 x 43 x 739mm (17.2" x 1.7" x 29.1") Package: 605 x 203 x 950mm (23.81" x 7.99" x 37.4")	1U Rackmount Enclosure: 437 x 43 x 754mm (17.2" x 1.7" x 29.7") Package: 605 x 203 x 950mm (23.81" x 7.99" x 37.4")	2U Rackmount Enclosure: 437 x 89 x 717.2mm (17.2" x 3.5" x 28.2") Package: 625 x 253 x 1154mm (24.6" x 9.96" x 45.43")





#### 12x 3.5" NVMe/SAS/SATA Drives







MODEL	SYS-620C-TN12R	SYS-610C-TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>CDN, Edge Nodes</li> <li>DNS &amp; Gateway Servers, Firewall Application</li> <li>Cloud Computing, Compact Server</li> <li>Data Center Optimized, Value laaS</li> <li>Web Server, Firewall Application</li> </ul>	<ul> <li>CDN, Edge Nodes</li> <li>DNS &amp; Gateway Servers, Firewall Application</li> <li>Cloud Computing, Compact Server</li> <li>Data Center Optimized, Value laaS</li> <li>Web Server, Firewall Application</li> </ul>
Outstanding Features	<ul> <li>Up to 12x NVMe/SATA/SAS hybrid tool-less drive bays</li> <li>Optional hot-swappable 2.5" rear drive bays</li> <li>Flexible expansion with up to 2x PCI-E 4.0 x16 and 4x PCI-E 4.0 x8 (convertible to 2x PCI-E 4.0 x16) slots</li> <li>Dual sockets up to 76 cores and 270W TDP</li> <li>Dual NVMe M.2 (2280)</li> <li>Dual FHFLDW PCI-E 4.0 GPU support</li> <li>Dual AIOM with NCSI (OCP 3.0 NIC)</li> <li>Compact server with tool-less drive trays</li> <li>Balanced architecture in compact chassis (25.6")</li> <li>3.5" tool-less drive trays also support 2.5" drives</li> </ul>	<ul> <li>Up to 4x SATA/SAS tool-less drive bays</li> <li>Optional fixed 2.5" 7 mm drive bays</li> <li>Flexible expansion with up to 2x PCI-E 5.0 x16 slots</li> <li>Flexible expansion with up to 2x PCI-E 4.0 x16 slots</li> <li>Dual sockets up to 76 cores and 270W TDP</li> <li>Dual NVMe M.2 (2280)</li> <li>Dual AIOM with NCSI (OCP 3.0 NIC)</li> <li>Compact server with tool-less drive trays</li> <li>Balanced architecture in compact chassis (25.6")</li> <li>3.5" tool-less drive trays also support 2.5" drives</li> </ul>
Serverboard	SUPER®® X12DDW-A6	SUPER●® X12DDW-A6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4 TB Intel® DCPMM, DDR4-3200MHz Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4 TB Intel® DCPMM, DDR4-3200MHz Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	2 PCI-E 4.0 x16 FHHL slot(s) 4 PCI-E 4.0 x16 FHFL slot(s)	2 PCI-E 4.0 x16 FHHL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	via AIOM	via AIOM
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SCC; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SCC; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	12x 3.5" hot-swap NVMe/SATA/SAS hybrid drive bays; Optional RAID support via RAID controller AOC	4x 3.5" hot-swap SATA/SAS hybrid drive bays; Optional RAID support via RAID controller AOC
Peripheral Bays	None	2x 2.5" (optional)
Power Supply	Redundant 1200W Titanium level (96%)	Redundant 860W Platinum level (94%)
Cooling System	3x 8cm heavy duty fan(s)	6x 4cm heavy duty fan(s)
Form Factor	2U rackmount Enclosure: 437 x 89 x 648mm (17.2" x 3.5" x 25.5")	1U rackmount Enclosure: 437 x 43 x 650mm (17.2" x 1.7" x 25.6")



#### 10x 2.5" NVMe/SAS/SATA Drives

8x 2.5" SAS/SATA Drives





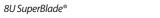


MODEL	SYS-120C-TN10R	SYS-120C-TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>CDN, Edge Nodes</li> <li>DNS &amp; Gateway Servers, Firewall Application</li> <li>Cloud Computing, Compact Server</li> <li>Data Center Optimized, Value IaaS</li> <li>Web Server, Firewall Application</li> </ul>	<ul> <li>CDN, Edge Nodes</li> <li>DNS &amp; Gateway Servers, Firewall Application</li> <li>Cloud Computing, Compact Server</li> <li>Data Center Optimized, Value laaS</li> <li>Web Server, Firewall Application</li> </ul>
Outstanding Features	<ul> <li>Up to 10x NVMe/SATA/SAS hybrid tool-less drive bays</li> <li>Flexible expansion with up to 2x PCI-E 5.0 x16 slots</li> <li>Flexible expansion with up to 2x PCI-E 4.0 x16 slots</li> <li>Dual sockets up to 76 cores and 270W TDP</li> <li>Dual NVMe M.2 (2280)</li> <li>Dual AIOM with NCSI (OCP 3.0 NIC)</li> <li>Compact server with tool-less drive trays</li> <li>Balanced architecture in compact chassis (23.5")</li> </ul>	<ul> <li>Up to 8x SATA/SAS tool-less drive bays</li> <li>Optional DVD ROM support</li> <li>Flexible expansion with up to 2x PCI-E 5.0 x16 slots</li> <li>Flexible expansion with up to 2x PCI-E 4.0 x16 slots</li> <li>Dual NVMe M.2 (2280)</li> <li>Dual AIOM with NCSI (OCP 3.0 NIC)</li> <li>Compact server with tool-less drive trays</li> <li>Balanced architecture in compact chassis (23.5")</li> </ul>
Serverboard	SUPER●° X12DDW-A6	SUPER●° X12DDW-A6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4 TB Intel® DCPMM, DDR4-3200MHz Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4 TB Intel® DCPMM, DDR4-3200MHz Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	2 PCI-E 4.0 x16 FHHL slot(s)	2 PCI-E 4.0 x16 FHHL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	via AIOM	via AIOM
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SCC; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SCC; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	10x 2.5" hot-swap NVMe/SATA/SAS hybrid drive bays; Optional RAID support via RAID controller AOC	8x 2.5" hot-swap SATA/SAS drive bays; Optional RAID support via RAID controller AOC
Peripheral Bays	None	1x DVD-ROM (optional)
Power Supply	Redundant 860W Platinum level (94%)	Redundant 860W Platinum level (94%)
Cooling System	6x 4cm heavy duty fan(s)	6x 4cm heavy duty fan(s)
Form Factor	1U rackmount Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5")	1U rackmount Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5")

# X12 SUPERBLADE®

NEW! 3rd Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable





6U SuperBlade®

4U SuperBlade®







Enclosure	SBE-820H/C/J/L-822/622/422	SBE-610J-822/622/422	SBE-414J-422/222
Processor Blade	Up to 20 hot-pluggable half-height 1-socket or 2-socket blade servers Up to 10 hot-pluggable full-height 4-socket blade servers Mixing of blade servers in a single enclosure allowed	Up to 10 hot-pluggable 1-socket or 2-socket blade servers	Up to 14 hot-pluggable 2-socket blade servers
LED	Power LED, Fault LED	Power LED, Fault LED	Power LED, Fault LED
InfiniBand Switch	<ul> <li>SBE-820H only</li> <li>Single 200G HDR InfiniBand switch with add-on card</li> <li>SBE-820C/CB only</li> <li>Single 100G EDR InfiniBand or Intel Omni-Path switch with add-on card</li> </ul>	N/A	N/A
Ethernet Switch	SBE-820J/JB only Up to 4 switches, 2 hot-pluggable 25G Ethernet switches and 2 hot-pluggable 25G Ethernet switches with add-on card SBE-820H/C/CB only Up to 2 hot-pluggable 25G Ethernet switches SBE-820L only Up to 2 hot-pluggable 10G Ethernet switches	Up to 4 hot-pluggable 25G/10G/1G Ethernet switches	Up to 2 hot-pluggable 25G/10G/1G Ethernet switches
Chassis Management Module (CMM)	Up to 2 CMM for remote system management with software	Up to 2 CMM for remote system management with software	Single CMM for remote system management with software
Available Models	SBE-820H/C/J/L-822 8x 2200W Titanium power supplies SBE-820H/C/J/L-622 6x 2200W Titanium power supplies SBE-820H/C/J/L-422 4x 2200W Titanium power supplies SBE-820H/C/J/L-6225 6x 2200W Platinium long-life power supplies + 2 long-life cooling fans SBE-820H/C/J/L-820D 8x 2000W DC power supplies SBE-820H/C/J/L-820D 4x 2000W DC power supplies + 4 cooling fans SBE-820CB/JB-422 4x 2200W Titanium power supplies + 4x 1200W BBP modules	SBE-610J-822 8x 2200W Titanium power supplies SBE-610J-622 6x 2200W Titanium power supplies SBE-610J-422 4x 2200W Titanium power supplies SBE-610J-622S 6x 2200W Platinum long-life power supplies + 2 long-life cooling fans SBE-610JB-422 4x 2200W Titanium power supplies + 4x 1200W BBP modules	SBE-414J-422 4x 2200W Titanium power supplies SBE-414J-222 2x 2200W Titanium power supplies
Rack Unit	8U	6U	4U
Dimensions (H x W x D)	356 x 447 x 813mm (14" x 17.6" x 32")	267 x 447 x 813mm (10.5" x 17.6" x 32")	178 x 447 x 813mm (7" x 17.6" x 32")

# X12 SUPERBLADE®

3rd Gen Intel® Xeon® Scalable processors Supported



8U/20-Blade w/ 3 SATA or 2 NVMe



8U/20-Blade w/ 2 SATA/NVMe





4U/14-Blade w/ 2 SATA/NVMe

MODEL	SBI-420P-1T3N	Liquid Cooling (OEM SKU*)	SBI-420P-1C2N	SBI-420P-4T2N
Processor Support	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported TDP up to 220W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported TDP up to 220W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported TDP up to 165W; 3 UPI
Key Applications	HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services	HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services	HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services	HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services
Outstanding Features	<ul> <li>Air cooling</li> <li>Advanced networking (InfiniBand, OmniPath)</li> </ul>	<ul> <li>Direct liquid cooling</li> <li>Advanced networking (InfiniBand, OmniPath)</li> </ul>	<ul> <li>High performance, high density</li> <li>Advanced networking (InfiniBand, OmniPath)</li> <li>SAS with hardware RAID 1</li> </ul>	<ul><li> Value and density optimized</li><li> High performance</li></ul>
Serverboard	SUPER●® B12DPT-6	SUPER●® B12DPT-6	SUPER●® B12DPT-6	SUPER●® B12DPT-6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4 TB ECC RDIMM, DDR4- 3200MHz Up to 4 TB ECC LRDIMM, DDR4- 3200MHz Up to 2 TB Intel® DCPMM, DDR4- 3200MHz	16 DIMM slots Up to 4 TB ECC RDIMM, DDR4- 3200MHz Up to 4 TB ECC LRDIMM, DDR4- 3200MHz Up to 2 TB Intel® DCPMM, DDR4- 3200MHz	16 DIMM slots Up to 4 TB ECC RDIMM, DDR4- 3200MHz Up to 4 TB ECC LRDIMM, DDR4- 3200MHz Up to 2 TB Intel® DCPMM, DDR4- 3200MHz	16 DIMM slots Up to 512GB VLP RDIMM, DDR4- 3200MHz
Expansion Slots	1 PCI-E 4.0 x16 slot for mezzanine option	1 PCI-E 4.0 x16 slot for mezzanine option	1 PCI-E 4.0 x16 slot for mezzanine option	N/A
Onboard Storage Controller	Intel® PCH 3.0 SATA Controller	Intel® PCH 3.0 SATA Controller	Broadcom® 3108 SAS Controller	Intel PCH 3.0 SATA Controller
Connectivity	Dual-port 25GbE LOM Mezzanine option for 2x25GbE, 200G/100G InfiniBand	Dual-port 25GbE LOM Mezzanine option for 2x25GbE, 200G/100G InfiniBand	Dual-port 25GbE LOM Mezzanine option for 2x25GbE, 200G/100G InfiniBand	Dual-port 25GbE LOM
VGA/Audio	One VGA connector and one COM port on KVM dongle	One VGA connector and one COM port on KVM dongle	One VGA connector and one COM port on KVM dongle	KVM over IP, Virtual Media over LAN
Management	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs
Drive Bays	1x M.2 NVMe 2x U.2 NVMe/SATA and 1x SATA Optional mezzanine 4x M.2 NVMe	1x M.2 NVMe 2x U.2 NVMe/SATA Optional mezzanine 4x M.2 NVMe	1x M.2 NVMe 2x U.2 NVMe/SAS/SATA Optional mezzanine 4x M.2 NVMe	1x M.2 NVMe 2x U.2 NVMe/SATA
Peripheral Bays	N/A	N/A	N/A	N/A
Power Supply	Up to 8x 2200W Titanium Level power supplies	Up to 8x 2200W Titanium Level power supplies	Up to 8x 2200W Titanium Level power supplies	Up to 4x 2200W Titanium Level power supplies
Cooling System	Up to 8x fans 3x System fan modules (optional)	Up to 8x fans 3x System fan modules	Up to 8x fans 3x System fan modules (optional)	4x PSU fans 3x System fan modules
Form Factor	8U Enclosure Up to 20x half-height blades	8U Enclosure Up to 20x half-height blades	8U Enclosure Up to 20x half-height blades	4U Enclosure Up to 14x blades

 $<sup>{\</sup>it * Contact Supermicro for more information}$ 



NEW! 3rd Gen Intel® Xeon® Scalable processors Supported



6U/10-Blade w/3 SAS or 2 NVMe

6U/10-Blade w/3 SATA/NVMe



6U/10-Blade w/2 SAS/NVMe







MODEL	SBI-610P-1C2N	SBI-610P-1T2N	SBI-620P-1C3N	SBI-620P-1T3N
Processor Support	3rd Gen Intel® Xeon® Scalable processor; Single Socket supported; TDP up to 270W	3rd Gen Intel® Xeon® Scalable processor; Single Socket supported; TDP up to 270W	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported; TDP up to 270W; 3UPI	3rd Gen Intel® Xeon® Scalable processors; Dual Socket supported; TDP up to 270W; 3UPI
Key Applications	<ul> <li>HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services</li> </ul>	<ul> <li>HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services</li> </ul>	<ul> <li>HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services</li> </ul>	HPC, Hybrid Cloud, EDA, Virtualization, Health, Financial Services
Outstanding Features	<ul> <li>High performance 1S with max memory footprint</li> <li>2 PCI-E 4.0 x16 slots for GPUs, or industry-standard PCI-E cards</li> <li>SAS with hardware RAID 1</li> </ul>	<ul> <li>High performance 1S with max memory footprint</li> <li>2 PCI-E 4.0 x16 slots for GPUs, or industry-standard PCI-E cards</li> <li>Support up to 4x 25GbE networks</li> </ul>	<ul> <li>High performance 2S with max memory footprint</li> <li>Support up to 4x 25GbE networks</li> <li>SAS with hardware RAID 0/1/5</li> </ul>	<ul> <li>High performance 2S with max memory footprint</li> <li>Support up to 4x 25GbE networks</li> </ul>
Serverboard	SUPER●® B12SPE	SUPER●® B12SPE	SUPER●® B12DPE	SUPER●® B12DPE
Chipset	Intel C621A	Intel C621A	Intel C621A	Intel C621A
System Memory (Max.)	16 DIMM slots; Up to 4TB Intel® DCPMM, DDR4- 3200MHz; Up to 4TB ECC LRDIMM, DDR4- 3200MHz; Up to 4TB ECC RDIMM, DDR4- 3200MHz	16 DIMM slots; Up to 4TB Intel® DCPMM, DDR4- 3200MHz; Up to 4TB ECC LRDIMM, DDR4- 3200MHz; Up to 4TB ECC RDIMM, DDR4- 3200MHz	32 DIMM slots; Up to 8TB Intel® DCPMM, DDR4- 3200MHz; Up to 8TB ECC LRDIMM, DDR4- 3200MHz; Up to 8TB ECC RDIMM, DDR4- 3200MHz	32 DIMM slots; Up to 8TB Intel® DCPMM, DDR4- 3200MHz; Up to 8TB ECC LRDIMM, DDR4- 3200MHz; Up to 8TB ECC RDIMM, DDR4- 3200MHz
Expansion Slots	2 PCI-E 4.0 x16 slots 1 PCI-E 4.0 x16 slot for high-speed networking mezzanine connector	2 PCI-E 4.0 x16 slots 1 PCI-E 4.0 x16 slot for high-speed networking mezzanine connector	1 PCI-E 4.0 x16 slot for high-speed networking mezzanine connector	1 PCI-E 4.0 x16 slot for high-speed networking mezzanine connector
Onboard Storage Controller	Broadcom 3108 SAS Controller	Intel PCH 3.0 SATA Controller	Broadcom 3108 SAS Controller	Intel PCH 3.0 SATA Controller
Connectivity	Dual-port 25GbE LOM Mezzanine option for 2x25GbE	Dual-port 25GbE LOM Mezzanine option for 2x25GbE	Dual-port 25GbE LOM Mezzanine option for 2x25GbE	Dual-port 25GbE LOM Mezzanine option for 2x25GbE
VGA/Audio	KVM over IP, Virtual Media over LAN	KVM over IP, Virtual Media over LAN	KVM over IP, Virtual Media over LAN	KVM over IP, Virtual Media over LAN
Management	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs	Redundant Chassis Management Modules, Blade Network Manager, Open Industry Standard IPMI, Redfish APIs
Drive Bays	2x U.2 NVMe/SAS/SATA 1x M.2 NVMe/SATA	2x U.2 NVMe/SATA 1x M.2 NVMe/SATA 2x M.2 NVMe	2x U.2 NVMe/SAS/SATA 1x U.2 SAS/SATA	3x U.2 NVMe/SATA
Peripheral Bays	N/A	N/A	N/A	N/A
Power Supply	Up to 8x 2200W Titanium Level power supplies	Up to 8x 2200W Titanium Level power supplies	Up to 8x 2200W Titanium Level power supplies	Up to 8x 2200W Titanium Level power supplies
Cooling System	Up to 8x fans	Up to 8x fans	Up to 8x fans	Up to 8x fans
Form Factor	6U Enclosure Up to 10x blades	6U Enclosure Up to 10x blades	6U Enclosure Up to 10x blades	6U Enclosure Up to 10x blades







Universal 4U GPU System







4U 10-GPU



MODEL	SYS-420GU-TNXR	SYS-420GP-TNAR SYS-420GP-TNAR+	SYS-420GP-TNR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul><li>Al/Deep Learning Training</li><li>High Performance Computing</li></ul>	<ul><li>Al/Deep Learning Training</li><li>High Performance Computing</li></ul>	<ul><li>Al/Deep Learning Training</li><li>VDI</li><li>Rendering</li><li>High Performance Computing</li></ul>
Outstanding Features		<ul> <li>Highest GPU communication using NVIDIA® NVLINK™ + NVIDIA® NVSwitch™</li> <li>High density 4U system with NVIDIA® HGX™ A100 8-GPU</li> <li>AIOM / OCP 3.0 Support</li> <li>8 NIC for GPU direct RDMA (1:1 GPU Ratio)</li> <li>4 NVMe for GPU direct storage</li> <li>2 M.2 NVMe and SATA for boot drive only</li> </ul>	<ul> <li>Up to 10 double width, full length GPUs</li> <li>Thermal performance with separate GPU &amp; CPU Zones</li> <li>Flexible GPU support: active &amp; passive GPUs</li> <li>AIOM / OCP 3.0 Support</li> <li>2x USB 3.0</li> <li>2 M.2 NVMe for boot drive only</li> </ul>
Serverboard	SUPER●° X12DGU	SUPER●® X12DGO-6	SUPER●® X12DPG-OA6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	32 DIMM slots Up to 8TB ECC LRDIMM, DDR4-3200MHz	32 DIMM slots Up to 8TB ECC LRDIMM, DDR4-3200MHz	32 DIMM slots Up to 8TB ECC LRDIMM, DDR4-3200MHz
Expansion Slots	10 PCI-E 4.0 X16 LP Slots	10 PCI-E 4.0 X16 LP Slots	12 PCI-E 4.0 X16 Slots
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550-AT2	2x 10GbE RJ45 with Intel® X550-AT2 (optional)	2x 1GbE RJ45 port(s) with Intel® Ethernet Controller I350
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC ); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC ); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	10x 2.5" hot-swap NVMe/SATA/SAS drive bays;	6x 2.5" hot-swap NVMe/SATA/SAS drive bays; 6x 2.5" NVMe hybrid; 4x 2.5" NVMe dedicated;	24x 2.5" hot-swap NVMe/SATA/SAS drive bays; 8x 2.5" NVMe dedicated;
Peripheral Bays	None	None	None
Power Supply	Redundant 3000W Titanium level (96%)	-TNAR: Redundant 2200W Titanium level (96%) -TNAR+: Redundant 3000W Titanium level (96%)	Redundant 2000W Titanium level (80%)
Cooling System	5 heavy duty fan(s)	4 heavy duty fan(s)	8 heavy duty fan(s)
Form Factor	4U Rackmount Enclosure: 449 x 175.6 x 833mm (17.67" x 6.91" x 32.79") Package: 700 x 370 x 1260mm (27.55" x 14.57" x 49.6")	4U Rackmount Enclosure: 446 x 174 x 900mm (17.6" x 6.9" x 35.4") Package: 695 x 750 x 1140mm (27.4" x 29.5" x 44.9")	4U Rackmount Enclosure: 437 x 178 x 737mm (17.2" x 7" x 29") Package: (27" x 26.57" x 41")



3rd Gen Intel® Xeon® Scalable processors Supported











1U 4-GPU



MODEL	SYS-740GP-TNRT	SYS-220GP-TNR	SYS-120GQ-TNRT
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul><li>Al/Deep Learning Training</li><li>Rendering</li><li>High Performance Computing</li><li>Scientific Virtualization</li></ul>	<ul><li>Al/Deep Learning Training</li><li>VDI</li><li>High Performance Computing</li><li>Scientific Virtualization</li></ul>	<ul><li>Al/Deep Learning Training</li><li>Rendering</li><li>High Performance Computing</li><li>Scientific Virtualization</li></ul>
Outstanding Features	<ul> <li>Up to 4 double width GPUs</li> <li>Flexible I/O support: 7 PCI-E slots</li> <li>Flexible GPU support: active &amp; passive GPUs</li> <li>2 M.2 NVMe and SATA for boot drive only</li> </ul>	<ul> <li>Up to 6 double width GPUs</li> <li>Flexible I/O support: 8 PCI-E Slots &amp; AIOM Support</li> <li>AIOM / OCP 3.0 Support</li> <li>2xM.2 with internal adaptor for boot drive only</li> <li>2x Front USB 3.0</li> </ul>	<ul> <li>Up to 4 double width GPUs</li> <li>Highest density GPU system</li> <li>Flexible GPU support: active &amp; passive GPUs</li> <li>2x Front USB 3.0</li> </ul>
Serverboard	SUPER●® X12DPG-QT6	SUPER●° X12DPG-AR	SUPER●° X12DGQ-R
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC LRDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC LRDIMM, DDR4-3200MHz Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC LRDIMM, DDR4-3200MHz Up to 4TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	6 PCI-E 4.0 X16 FHFL Slots, 1 PCI-E 4.0 X 8 LP Slots	6 PCle 4.0 x16 FHFL, 2 PCle 4.0 x8 FH	4 PCI-E 4.0 x16 (FHFL), 1 PCI-E 4.0 x16 (LP)
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 port(s)	via AIOM	2x 10GbE RJ45 port(s)
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC ); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC ); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; OOB Management Package (SFT-OOB-LIC ); Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	8x 3.5" hot-swap NVMe/SATA/SAS Support drive bays; 10x 2.5" NVMe dedicated;	10x 2.5" hot-swap NVMe/SATA/SAS drive bays; 2x 2.5" NVMe dedicated;	4x 2.5" hot-swap NVMe/SATA/SAS drive bays; 2x 2.5" NVMe dedicated;
Peripheral Bays	None	None	None
Power Supply	2200W Titanium level (96%)	2600W Redundant Power Supplies with PMBus	2000W Redundant Power Supplies with PMBus
Cooling System	4 heavy duty fan(s)	5 heavy duty fan(s)	9 heavy duty fan(s)
Form Factor	Full-Tower Rackmount Enclosure: 178 x 460 x 673mm (7" x 18.1" x 26.5") Package: 685.8 x 322.6 x 952.5mm (27" x 12.7" x 37.5")	2U Rackmount Enclosure: 440.7 x 88 x 766.8mm (17.35" x 3.46" x 30.18") Package: 673 x 279 x 1130mm (26.5" x 11" x 44.5")	1U Rackmount Enclosure: 437 x 43 x 894mm (17.2" x 1.7" x 35.2") Package: 609.6 x 203.2 x 1168.4mm (24" x 8" x 46")



NEW! 3rd Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable



1U 12x Drives



2U 12x Drives



2U 16x Drives



MODEL	SSG-610P-ACR12N4H SSG-610P-ACR12N4L	SSG-620P-ACR12H SSG-620P-ACR12L	SSG-620P-ACR16H SSG-620P-ACR16L
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; Database Applications	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>Database Applications</li> <li>Scale-out NAS</li> <li>Hadoop &amp; Ceph storage solutions</li> <li>Scale-Out Density</li> <li>Big Data Analytics</li> <li>Object Storage</li> <li>Hyperscale Data Center</li> </ul>	<ul> <li>Appliance Optimized Storage Building Blocks</li> <li>Enterprise Database Applications</li> <li>Big Data Analytic and HPC</li> <li>On Premise Converged Infrastructure</li> </ul>	<ul> <li>Appliance Optimized Storage Building Blocks</li> <li>Enterprise Database Applications</li> <li>Big Data Analytic and HPC</li> <li>On Premise Converged Infrastructure</li> </ul>
Outstanding Features	<ul> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>Dual socket 3rd Gen Intel® Xeon® Scalable processors, up to 72 Cores</li> <li>4 Front EDSFF Short Slots + 2 SATA NVMe Slots</li> <li>2 x 25G SFP+ onboard</li> <li>2 PCI-E 4.0 X16 Slots + 1 PCI-E 4.0 x8 Slots</li> <li>16 ECC DDR4-3200:LRDIMM/RDIMM;</li> <li>12 Hot-swap 3.5" SAS3/SATA3 drive bays</li> <li>1 PCI-E 4.0 x8 AIOM slot</li> </ul>	<ul> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>Onboard 1 M.2 NVMe/SATA</li> <li>Dual socket 3rd Gen Intel® Xeon® Scalable processors, up to 72 Cores</li> <li>4 PCI-E 4.0 x16 Slots + 2 PCI-E 4.0 x8 Slots</li> <li>16 ECC DDR4-3200:LRDIMM/RDIMM; +2 Intel® DCPMM</li> <li>12 Hot-swap 3.5" NVMe/SAS3/SATA3 drive bays</li> </ul>	Level (96%)  12 Hot-swap 3.5" Hybrid NVMe/SAS3/SATA3 drive bays+ 4 SAS3/SATA3 Drive Bays; on board 1 M.2 NVMe  - ACR16H: Broadcom 3916 Controller - ACR16L: Broadcom 3816 Controller
Serverboard Chipset	SUPER® X12DPD-A6M25 Intel® C621A	SUPER® X12DPi-NT6 Intel® C621A	SUPER® X12DPi-NT6 Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz	16 DIMM slots Up to 18TB Intel® DCPMM, DDR4-2666MHz	Intel® COZIA  16 DIMM slots Up to 18TB Intel® DCPMM, DDR4-2666MHz Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz
Expansion Slots	PCI-E 4.0 x16 AIOM slot(s) PCI-E 4.0 x8 LP slot(s) 2 PCI-E 4.0 x16 LP slot(s)	PCI-E 4.0 x8 LP slot(s) 4 PCI-E 4.0 x16 LP slot(s)	PCI-E 4.0 x8 LP slot(s) 4 PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	-ACR12N4H: -ACR12N4L:	-ACR12H: Intel® SATA Broadcom® AOC-S3916L-H16IR-32DD-O -ACR12L: Intel® SATA Broadcom® AOC-S3816L-L16IT	-ACR16H: Intel® SATA Broadcom® AOC-S3916L-H16IR-32DD-O -ACR16L: Intel® SATA Broadcom® AOC-S3816L-L16IT
Connectivity	2x 25GbE SFP28 port(s) with Mellanox	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio Management	1 VGA port IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog	1 VGA port	I VGA port IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog 16x 3.5" hot-swap SATA3/SAS3 drive bays; 4x
Drive Bays	12x 3.5" hot-swap SATA3/SAS3 drive bays; 2x 2.5" 7mm drive bays	3.5" NVMe hybrid; 4x 2.5" NVMe hybrid;	3.5" NVMe hybrid; Optional RAID support via RAID/HBA controller AOC
Peripheral Bays	None	None	None
Power Supply Cooling System	Redundant 800W Platinum level (94%) 6x 4cm heavy duty fan(s)	Redundant 1200W Titanium level (96%) 3x 8cm heavy duty fan(s)	Redundant 1600W Titanium level (96%) 4x 8cm heavy duty fan(s)
Form Factor	1U Rackmount Enclosure: (17.6" x 1.7" x 37") Package: (27" x 12" x 53.15")	2U Rackmount Enclosure: (17.3" x 3.5" x 25.5") Package: (27" x 12" x 35")	2U Rackmount Enclosure: 437 x 89 x 705mm (17.2" x 3.5" x 27.75") Package: 658 x 274 x 998mm (25.9" x 10.8" x 39.3")







2U Simply Double, 24x Drives







#### 4U 36x Drives



MODEL	SSG-620P-E1CR24H SSG-620P-E1CR24L	SSG-640P-E1CR24H SSG-640P-E1CR24L	SSG-640P-E1CR36H SSG-640P-E1CR36L
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>Appliance Optimized Storage Building Blocks</li> <li>Corporate Database</li> <li>Database Processing &amp; Storage</li> <li>HPC, Data Center</li> <li>iSCSI SAN</li> <li>Enterprise Server</li> </ul>	<ul> <li>Appliance Optimized Storage Building Blocks</li> <li>Corporate Database</li> <li>Database Processing &amp; Storage</li> <li>HPC, Data Center</li> <li>iSCSI SAN</li> <li>Enterprise Server</li> </ul>	<ul> <li>Corporate Database</li> <li>Database Processing &amp; Storage</li> <li>HPC, Data Center</li> <li>iSCSI SAN</li> <li>Enterprise Server</li> </ul>
Outstanding Features	<ul> <li>Support dual Intel® Xeon Scalable CPUs</li> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>High Density platform in 2U rack size</li> <li>Flexible storage media and controller configurations, and support tiering storage</li> </ul>	<ul> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>On board 1 M.2 NVMe/SATA</li> <li>Dual socket 3rd Gen Intel® Xeon® Scalable processors, up to 72 Cores</li> <li>4 PCI-E 4.0 x16 Slots + 2 PCI-E 4.0 x8 Slots</li> <li>24 Hot-swap 3.5" SAS3/SATA3 drive bays</li> <li>16 ECC DDR4-3200:LRDIMM/RDIMM; +2 Intel® DCPMM</li> </ul>	<ul> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>Onboard 1 M.2 NVMe/SATA</li> <li>Dual socket 3rd Gen Intel® Xeon® Scalable processors, up to 72 Cores</li> <li>4 PCI-E 4.0 x16 Slots + 2 PCI-E 4.0 x8 Slots</li> <li>32 Hot-swap 3.5" SAS3/SATA3 drive bays + 4 NVME/ SAS3/SATA3 Drive Bays</li> <li>16 ECC DDR4-3200:LRDIMM/RDIMM; +2 Intel® DCPMM</li> </ul>
Serverboard	SUPER●® X12DSC-A6	SUPER●® X12DPi-NT6	SUPER●® X12DPi-NT6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4- 3200MHz	16 DIMM slots Up to 18TB Intel® DCPMM, DDR4-2666MHz Up to 4TB ECC RDIMM/LRDIMM, DDR4- 3200MHz	16 DIMM slots Up to 18TB Intel® DCPMM, DDR4-2666MHz Up to 4TB ECC RDIMM/LRDIMM, DDR4- 3200MHz
Expansion Slots	PCI-E 4.0 x16 AIOM slot(s) 2 PCI-E 4.0 x16 LP slot(s)	PCI-E 4.0 x8 LP slot(s) 3 PCI-E 4.0 x16 LP slot(s)	PCI-E 4.0 x8 LP slot(s) 3 PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	-E1CR24H: Intel® SATA Broadcom® AOC-S3916L-H16IR-32DD-O -E1CR24L: Intel® SATA Broadcom® AOC-S3816L-L16IT	-E1CR24H: Intel® SATA Broadcom® AOC-S3908L-H8IR -E1CR24L: Intel® SATA Broadcom® AOC-S3808L-L8IT	-E1CR36H: Intel® SATA Broadcom® AOC-S3908L-H8IR -E1CR36L: Intel® SATA Broadcom® AOC-S3808L-L8IT
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	24x 3.5" hot-swap SATA3/SAS2 drive bays; Optional RAID support via RAID/HBA Controller AOC	24x 3.5" hot-swap SATA3/SAS3 drive bays; Optional RAID support via RAID/HBA controller AOC	36x 3.5" hot-swap SATA3/SAS3 drive bays; 4x 3.5" NVMe hybrid; Optional RAID support via RAID/HBA controller AOC
Peripheral Bays	None	None	None
Power Supply	Redundant 1600W Titanium level (96%)	Redundant 1200W Titanium level (96%)	1600W Redundant Power Supplies with PMBus
Cooling System	5x 8cm heavy duty fan(s)	5x 8cm heavy duty fan(s)	7x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: (17.2" x 3.5" x 34") Package: (29" x 12" x 52")	4U Rackmount Enclosure: 437 x 178 x 660mm (17.2" x 7" x 26") Package: 871 x 673 x 343mm (34.3" x 26.5" x 13.5")	4U Rackmount Enclosure: (17.2" x 7" x 27.5") Package: (27" x 15" x 39")



#### 4U 60x Top-loading









MODEL	SSG-640SP-E1CR60	SSG-640SP-E1CR90
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI
Key Applications	<ul> <li>Government Data Protection</li> <li>Content Repositories</li> <li>Financial Services &amp; Healthcare Image Archives</li> <li>Telco &amp; Cloud Service Providers</li> <li>HPC and Al/ML Workloads</li> <li>Big Data &amp; Analytics, Data Lake</li> </ul>	<ul> <li>Government Data Protection</li> <li>Content Repositories</li> <li>Financial Services &amp; Healthcare Image Archives</li> <li>Telco &amp; Cloud Service Providers</li> <li>HPC and AI/ML Workloads</li> <li>Big Data &amp; Analytics, Data Lake</li> </ul>
Outstanding Features	<ul> <li>Single Node with High Density in 4U rack space</li> <li>Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN</li> <li>Optional 4 NVMe SSD drives for caching</li> <li>Excellent Serviceability with Modular Design</li> <li>Drive Controller support via Broadcom® 3916 HW RAID or 3616 IT Mode</li> </ul>	<ul> <li>Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN</li> <li>Excellent Serviceability with Modular Design</li> <li>Drive Controller support via Broadcom® 3916 HW RAID or 3616 IT Mode</li> </ul>
Serverboard	SUPER●® X12DSC-6	SUPER●® X12DSC-6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz
Expansion Slots	3 PCI-E 4.0 x16 LP slot(s)	3 PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 port(s) with X550	2x 10GbE RJ45 port(s) with X550
VGA/Audio	1 VGA port	1 VGA port
Management	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	60x 3.5" hot-swap SATA3/SAS3 drive bays; 4x 2.5" NVMe dedicated; Optional RAID support via RAID/HBA controller AOC 2x 2.5" 7mm drive bays	90x 3.5" hot-swap SATA3/SAS3 drive bays; 4x 2.5" NVMe dedicated; Optional RAID support via RAID/HBA controller AOC 2x 2.5" 7mm drive bays
Peripheral Bays	None	None
Power Supply	2000W Redundant Power Supplies with PMBus	2600W Redundant Power Supplies with PMBus
Cooling System	6x 8cm heavy duty fan(s)	6x 8cm heavy duty fan(s)
Form Factor	4U Rackmount Enclosure: (17.6" x 7" x 34.1") Package: (31.89" x 29.92" x 44.88")	4U Rackmount Enclosure: (17.6" x 7" x 42.1") Package: (35.82" x 29.92" x 53.15")



#### 4U 60x Top-loading

4U 90x Top-loading







MODEL	SSG-640SP-DE1CR60 SSG-640SP-DE2CR60	SSG-640SP-DE1CR90 SSG-640SP-DE2CR90
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI
Key Applications	<ul> <li>Government Data Protection</li> <li>Content Repositories</li> <li>Financial Services &amp; Healthcare Image Archives</li> <li>Telco &amp; Cloud Service Providers</li> <li>HPC and Al/ML Workloads</li> <li>Big Data &amp; Analytics, Data Lake</li> </ul>	<ul> <li>Government Data Protection</li> <li>Content Repositories</li> <li>Financial Services &amp; Healthcare Image Archives</li> <li>Telco &amp; Cloud Service Providers</li> <li>HPC and AI/ML Workloads</li> <li>Big Data &amp; Analytics, Data Lake</li> </ul>
Outstanding Features	<ul> <li>Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN</li> <li>Excellent Serviceability with Modular Node Design</li> <li>Dual Node Twin Architecture, 2x the Compute (Each node controls 30 drives)</li> <li>Drive Controller support via Broadcom® 3916 HW RAID or 3616 IT Mode</li> </ul>	<ul> <li>Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN</li> <li>Excellent Serviceability with Modular Node Design</li> <li>Dual Node (HA), Enterprise High Availability (SBB) Architecture (shared storage); 2 Hot Pluggable Nodes</li> <li>Drive Controller support via Broadcom® 3616 IT Mode</li> </ul>
Serverboard	SUPER●® X12DSC-6	SUPER●° X12DSC-6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM/LRDIMM, DDR4-3200MHz
Expansion Slots	3 PCI-E 4.0 x16 LP slot(s)	3 PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	-DE1CR60: Intel® SATA Broadcom® 3916 -DE2CR60: Intel® SATA Broadcom® 3816	-DE1CR90: Intel® SATA Broadcom® 3916 -DE2CR90: Intel® SATA Broadcom® 3816
Connectivity	2x 10GbE RJ45 port(s) with X550	2x 10GbE RJ45 port(s) with X550
VGA/Audio	1 VGA port	1 VGA port
Management	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	60x 3.5" hot-swap SATA3/SAS3 drive bays; Optional RAID support via RAID/HBA controller AOC 2x 2.5" 7mm drive bays	90x 3.5" hot-swap SATA3/SAS3 drive bays; Optional RAID support via HBA controller AOC 2x 2.5" 7mm drive bays
Peripheral Bays	None	None
Power Supply	2600W Redundant Power Supplies with PMBus	2600W Redundant Power Supplies with PMBus
Cooling System	6x 8cm heavy duty fan(s)	6x 8cm heavy duty fan(s)
Form Factor	4U Rackmount Enclosure: (17.6" x 7" x 34.1") Package: (31.89" x 29.92" x 44.88")	4U Rackmount Enclosure: (17.6" x 7" x 42.1") Package: (35.82" x 29.92" x 53.15")

### X12 STORAGE

#### 4U UP 36x Drives





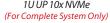
4U UP 45x Drives (For Complete System Only)



MODEL	SSG-540P-E1CTR36H SSG-540P-E1CTR36L	SSG-540P-E1CTR45H SSG-540P-E1CTR45L
Processor Support	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Appliance Optimized Storage</li><li>Database Processing &amp; Storage</li><li>Enterprise Server</li></ul>	<ul><li>Database Applications</li><li>Data Warehousing, Archiving</li><li>Backup Storage, Cold Storage</li></ul>
Outstanding Features	<ul> <li>Expander chip and JBOD support, up to 36x SATA/SAS drives with PCI-E 4.0 SAS Controller</li> <li>4U 36 Bay High Density Storage</li> <li>2x optional Gen 4 NVMe drives; onboard 1x M.2 NVMe/SATA</li> </ul>	<ul> <li>Top Loading with expander chip, up to 45x SATA/SAS drives with PCI-E 4.0 SAS Controller</li> <li>5 Hot-Swap 8cm redundant PWM fans</li> <li>2x optional Gen 4 NVMe drives + 2 rear Hot-swap 2.5" SATA drive bays; onboard 1x M.2 NVMe/SATA</li> </ul>
Serverboard	SUPER●® X12SPI-TF	SUPER●® X12SPI-TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz
Expansion Slots	2 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)	2 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)
Onboard Storage Controller	-E1CTR36H: Broadcom® 3908 -E1CTR36L: Broadcom® 3808	-E1CTR45H:Broadcom® 3908 -E1CTR45L: Broadcom® 3808
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM
Drive Bays	36x 3.5" hot-swap SATA/SAS drive bays;	2x 2.5" hot-swap SATA/SAS drive bays;
Peripheral Bays	2x 2.5" SATA or NVMe (optional)	2x 2.5" SATA
Power Supply	Redundant 1200W Titanium level (96%)	Redundant 1600W Platinum level (94%)
Cooling System	7x (8cm x 8cm x 3.8cm) heavy duty fan(s)	5x (8cm x 8cm x 3.8cm) heavy duty fan(s)
Form Factor	4U Rackmount Enclosure: 437 x 178 x 699mm (17.2" x 7" x 27.5") Package: 656 x 445 x 1003mm (27" x 17.5" x 39.5")	4U Rackmount Enclosure: 437 x 178 x 660mm (17.2" x 7" x 26") Package: 711 x 559 x 1067mm (28" x 22" x 42")

### X12 STORAGE

### 1U UP 10x NVMe











MODEL	SSG-110P-NTR10	SSG-520P-ACTR12H SSG-520P-ACTR12L
Processor Support	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Virtualization</li><li>CDN Optimized</li><li>All Flash Storage</li><li>Cloud Computing</li></ul>	<ul><li>Appliance Optimized Storage</li><li>Database Processing &amp; Storage</li><li>Enterprise Server</li></ul>
Outstanding Features	<ul> <li>Optimized Cooling with support up to 270W TDP processor</li> <li>2x NVMe/SATA M.2 supported</li> <li>10x NVMe tool-less drive bays</li> </ul>	<ul> <li>Server remote management: IPMI 2.0/KVM over LAN/Media over LAN</li> <li>Direct-attached 12x 3.5" hot-swap SATA/SAS drive bays with PCI-E 4.0 SAS Controller</li> <li>Cost-effective 2U rackmount storage</li> <li>2x optional Gen 4 NVMe drives; onboard 1x M.2 NVMe/SATA</li> </ul>
Serverboard	SUPER●® X12SPO-NTF	SUPER●° X12SPI-TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz
Expansion Slots	1 PCI-E 4.0 x16 FHHL slot(s)	2 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x8 LP slot(s)
Onboard Storage Controller	NVMe	-ACTR12H: Broadcom® 3916 -ACTR12L: Broadcom® 3816
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM
Drive Bays	10x 2.5" hot-swap NVMe drive bays;	12x 3.5" hot-swap SATA/SAS drive bays;
Peripheral Bays	None	2x 2.5" SATA or NVMe (optional)
Power Supply	Redundant 860W Platinum level (94%)	Redundant 800W Titanium level (96%)
Cooling System	6x (4cm x 4cm x 5.6cm) heavy duty fan(s)	3x (8cm x 8cm x 3.8cm) heavy duty fan(s)
Form Factor	1U Rackmount Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5") Package: 610 x 203 x 813mm (24" x 8" x 32")	2U Rackmount Enclosure: 437 x 89 x 650mm (17.2" x 3.5" x 25.6") Package: 673 x 292 x 864mm (26.5" x 11.5" x 34")

3rd Gen Intel® Xeon® Scalable processors Supported









MODEL	SYS-220P-C9R	SYS-220P-C9RT	SYS-620P-TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul> <li>Application-Optimized Solutions</li> <li>Database Processing and High Density Storage</li> <li>Data Center Optimized</li> <li>Enterprise Server</li> <li>High Performance Computing</li> </ul>	<ul> <li>Application-Optimized Solutions</li> <li>Database Processing and High Density Storage</li> <li>Data Center Optimized</li> <li>Enterprise Server</li> <li>High Performance Computing</li> </ul>	<ul> <li>Virtualization</li> <li>Compute Intensive Applications</li> <li>Model analysis</li> <li>Application and data serving</li> <li>Data Center Optimized</li> <li>Enterprise Server</li> </ul>
Outstanding Features	High end all-purpose 2U rackmount server	High end all-purpose 2U rackmount server	<ul> <li>Cost effective all-purpose 2U rackmount server</li> </ul>
Serverboard	SUPER●® X12DPi-N6	SUPER●® X12DPi-NT6	SUPER●® X12DPi-N6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)			
Expansion Slots	4x PCI-E 4.0 x16 LP slot(s); 1x PCI-E 4.0 x8 LP slot(s)	4x PCI-E 4.0 x16 LP slot(s); 1x PCI-E 4.0 x8 LP slot(s)	4x PCI-E 4.0 x16 LP slot(s); 2x PCI-E 4.0 x8 LP slot(s)
Onboard Storage Controller	Intel® C621A Broadcom® 3908	Intel® C621A Broadcom® 3908	Intel® C621A
Connectivity	2x 1GbE port(s)	2x 10GbE port(s)	2x 1GbE port(s)
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License
Drive Bays	6x 2.5" hot-swap drive bays; 4x 2.5" NVMe optional	6x 2.5" hot-swap drive bays; 4x 2.5" NVMe optional	8x 3.5" hot-swap drive bays; 2x 2.5" NVMe fixed drives optional
Peripheral Bays	1x (slim or 5.25") DVD (optional)	1x (slim or 5.25") DVD (optional)	1x slim DVD (optional)
Power Supply	Redundant 1200W Titanium level (96%)	Redundant 1200W Titanium level (96%)	Redundant 1200W Titanium level (96%)
Cooling System	3 heavy duty fan(s)	3 heavy duty fan(s)	3 heavy duty fan(s)
Form Factor	2U rackmount Enclosure: 437 x 89 x 630mm (17.2" x 3.5" x 24.8")	2U rackmount Enclosure: 437 x 89 x 630mm (17.2" x 3.5" x 24.8")	2U rackmount Enclosure: 437 x 89 x 647mm (17.2" x 3.5" x 25.5")

NEW! 3rd Gen Intel® Xeon® Scalable processors Supported



DP Mainstream



UP Mainstream



**UP Mainstream** 



MODEL	SYS-620P-TRT	SYS-510P-M	SYS-510P-MR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 220W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 220W;
Key Applications	<ul> <li>Virtualization</li> <li>Compute Intensive Applications</li> <li>Model analysis</li> <li>Application and data serving</li> <li>Data Center Optimized</li> <li>Enterprise Server</li> </ul>	<ul><li>Email/Firewall/Print Server</li><li>Web/Hosting Application</li><li>Small Business</li></ul>	<ul><li>Email/Firewall/Print Server</li><li>Web/Hosting Application</li><li>Small Business</li></ul>
Outstanding Features	Cost effective all-purpose 2U rackmount server	<ul><li>Short Depth</li><li>Cost Effective</li><li>2x NVMe/SATA M.2 supported</li></ul>	<ul><li>Short Depth.</li><li>Cost Effective.</li><li>2x NVMe/SATA M.2 supported.</li></ul>
Serverboard	SUPER●® X12DPi-NT6	SUPER●® X12SPO-F	SUPER●° X12SPO-F
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)		8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz
Expansion Slots	4x PCI-E 4.0 x16 LP slot(s); 2x PCI-E 4.0 x8 LP slot(s)	1 PCI-E 4.0 x16 FHHL slot(s)	1 PCI-E 4.0 x16 FHHL slot(s)
Onboard Storage Controller	Intel® C621A	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE port(s)	2x 1GbE RJ45 port(s) with Intel® Ethernet Controller i350	2x 1GbE RJ45 port(s) with Intel® Ethernet Controller i350
VGA/Audio	1 VGA port	1 onboard VGA port	1 onboard VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM
Drive Bays	8x 3.5" hot-swap drive bays; 2x 2.5" NVMe fixed drives optional	4x 3.5" NVMe/SATA drive bays; 4x 3.5" NVMe hybrid;	4x 3.5" NVMe/SATA drive bays; 4x 3.5" NVMe hybrid;
Peripheral Bays	1x slim DVD (optional)	2x 2.5"	2x 2.5"
Power Supply	Redundant 1200W Titanium level (96%)	500W Platinum level (94%)	Redundant 400W Platinum level (94%)
Cooling System	3 heavy duty fan(s)	4x (4cm x 4cm x 2.8cm) heavy duty fan(s)	4x (4cm x 4cm x 2.8cm) heavy duty fan(s)
Form Factor	2U rackmount Enclosure: 437 x 89 x 647mm (17.2" x 3.5" x 25.5")	1U Rackmount Enclosure: 437 x 43 x 507mm (17.2" x 1.7" x 19.98") Package: 609.6 x 215.9 x 749.3mm (24" x 8.5" x 29.5")	1U Rackmount Enclosure: 437 x 43 x 507mm (17.2" x 1.7" x 19.98") Package: 609.6 x 215.9 x 749.3mm (24" x 8.5" x 29.5")

3rd Gen Intel® Xeon® Scalable processors Supported



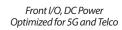


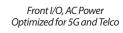


MODEL	SYS-740P-TR	SYS-740P-TRT
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul> <li>Office environment</li> <li>Compute Intensive Applications</li> <li>Model analysis</li> <li>Application and data serving</li> <li>Enterprise Server</li> </ul>	<ul> <li>Office environment</li> <li>Compute Intensive Applications</li> <li>Model analysis</li> <li>Application and data serving</li> <li>Enterprise Server</li> </ul>
Outstanding Features	Cost-effective all-purpose tower server	Cost-effective all-purpose tower server
Serverboard	SUPER●® X12DPi-N6	SUPER●° X12DPi-NT6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)		
Expansion Slots	4 PCI-E 4.0 x16 Full-height slot(s); 2 PCI-E 4.0 x8 Full-height slot(s)	4 PCI-E 4.0 x16 Full-height slot(s); 2 PCI-E 4.0 x8 Full-height slot(s)
Onboard Storage Controller	Intel® C621A	Intel® C621A
Connectivity	2x 1GbE port(s)	2x 10GbE port(s)
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; Supermicro Out of Band (OOB) License
Drive Bays	8x 3.5" hot-swap drive bays; 2x 2.5" NVMe hybrid; 2.5" NVMe fixed drives optional	8x 3.5" hot-swap drive bays; 2x 2.5" NVMe hybrid; 2.5" NVMe fixed drives optional
Peripheral Bays	1x 5.25" DVD (optional)	1x 5.25" DVD (optional)
Power Supply	Redundant 1200W Titanium level (96%)	Redundant 1200W Titanium level (96%)
Cooling System	3 (middle) and 2 (rear) heavy duty fans	3 (middle) and 2 (rear) heavy duty fans
Form Factor	Tower/4U rackmount Enclosure: 178 x 452 x 648mm (7" x 17.8" x 25.5")	Tower/4U rackmount Enclosure: 178 x 452 x 648mm (7" x 17.8" x 25.5")













MODEL	SYS-220HE-FTNRD	SYS-220HE-FTNR
Processor Support	Dual Socket supported TDP up to 270W; 3 UPI	Dual Socket supported TDP up to 270W; 3 UPI
Key Applications		
Outstanding Features	Front I/O, tool-less design	• Front I/O, tool-less design
Serverboard	SUPER●® X12DHM-6	SUPER●® X12DHM-6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)		
Expansion Slots	3 PCI-E 4.0 x16 DW FHFL or 6 x8 SW FHFL slot(s) PCI-E 4.0 x16 SW FHHL or 2 x8 SW FHHL slot(s)	3 PCI-E 4.0 x16 DW FHFL or 6 x8 SW FHFL slot(s) PCI-E 4.0 x16 SW FHHL or 2 x8 SW FHHL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	2x 100GbE QSFP28 with Broadcom® BCM57508 (optional) 2x 10GbE RJ45 with Intel® X550-AT2 (optional) 2x 10GbE SFP+ with Intel® X710-BM2 (optional) 2x 1GbE RJ45 with Intel® i350-AM2 (optional) 2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 4x 10GbE RJ45/SFP+ with Intel® X710-TM4 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 1GbE SFP or 4x 1GbE RJ45 with Intel® i350-AM4 (optional) 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional) via AIOM	2x 100GbE QSFP28 with Broadcom® BCM57508 (optional) 2x 10GbE RJ45 with Intel® X550-AT2 (optional) 2x 10GbE SFP+ with Intel® X710-BM2 (optional) 2x 1GbE RJ45 with Intel® i350-AM2 (optional) 2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 4x 10GbE RJ45/SFP+ with Intel® X710-TM4 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 1GbE SFP or 4x 1GbE RJ45 with Intel® i350-AM4 (optional) 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional) via AIOM
VGA/Audio	1 VGA port	1 VGA port
Management		
Drive Bays	6x 2.5" hot-swap NVMe/SATA drive bays; 6x 2.5" NVMe hybrid; Optional RAID support via RAID Controller AOC	6x 2.5" hot-swap NVMe/SATA drive bays; 6x 2.5" NVMe hybrid; Optional RAID support via RAID Controller AOC
Peripheral Bays	None	None
Power Supply	1300W DC -48V redundant (typical 92%)	2000W or 1200W AC redundant Titanium Level (typical 96%)
Cooling System	6x 6cm heavy duty fan(s)	6x 6cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 436.88 x 88.9 x 574mm (17.2" x 3.5" x 22.6") Package: 598 x 247 x 938mm (23.5" x 9.7" x 36.9")	2U Rackmount Enclosure: 436.88 x 88.9 x 574mm (17.2" x 3.5" x 22.6") Package: 598 x 247 x 938mm (23.5" x 9.7" x 36.9")





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MODEL	SYS-220H-TN24R	SYS-620H-TN12R	SYS-120H-TNR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI
Key Applications	<ul> <li>Software-defined Storage</li> <li>Virtualization</li> <li>Enterprise Server</li> <li>Cloud Computing</li> <li>Al Inference and Machine Learning</li> </ul>	<ul> <li>Software-defined Storage</li> <li>Virtualization</li> <li>Enterprise Server</li> <li>Cloud Computing</li> <li>Al Inference and Machine Learning</li> </ul>	<ul> <li>Software-defined Storage</li> <li>Virtualization</li> <li>Enterprise Server</li> <li>Cloud Computing</li> <li>Al Inference and Machine Learning</li> </ul>
Outstanding Features	<ul> <li>Tool-less system design for easy maintenance</li> <li>Flexible networking options with AIOM/OCP NIC 3.0 support</li> <li>24x 2.5" hot-swap NVMe/SATA/SAS drive bays</li> </ul>	<ul> <li>Tool-less system design for easy maintenance</li> <li>Flexible networking options with AIOM/OCP NIC 3.0 support</li> <li>12x 3.5"/2.5" hot-swap NVMe/SATA/SAS drive bays</li> </ul>	<ul> <li>Storage configurations up to 12x 2.5" hot- swap NVMe/SATA/SAS drive bays</li> </ul>
Serverboard	SUPER●® X12DHM-6	SUPER●® X12DHM-6	SUPER●® X12DHM-6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	32 DIMM slots Up to 8TB Intel® DCPMM, DDR4-3200MHz Up to 8TB ECC LRDIMM, DDR4-3200MHz Up to 8TB ECC RDIMM, DDR4-3200MHz	32 DIMM slots Up to 8TB Intel® DCPMM, DDR4-3200MHz Up to 8TB ECC LRDIMM, DDR4-3200MHz Up to 8TB ECC RDIMM, DDR4-3200MHz	32 DIMM slots Up to 8TB Intel® DCPMM, DDR4-3200MHz Up to 8TB ECC LRDIMM, DDR4-3200MHz Up to 8TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	Configurable PCI-E slot options up to 8 PCI-E 4.0 x8 or 4 PCI-E 4.0 x16 FH, 10.5"L	Configurable PCI-E slot options up to 8 PCI-E 4.0 x8 or 4 PCI-E 4.0 x16 FH, 10.5"L	3 PCI-E 4.0 x16 FH, 10.5"L
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® SATA
Connectivity	2x 100GbE QSFP28 with Broadcom® BCM57508 (optional) 2x 10GbE RJ45 with Intel® X550-AT2 (optional) 2x 10GbE SFP+ with Intel® X710-BM2 (optional) 2x 1GbE RJ45 with Intel® i350-AM2 (optional) 2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 4x 10GbE RJ45/SFP+ with Intel® X710-TM4 (optional) 4x 10GbE SFP+ with Intel® X710-BM1 (optional) 4x 10GbE SFP or 4x 1GbE RJ45 with Intel® i350-AM4 (optional) 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional) via AIOM	2x 100GbE QSFP28 with Broadcom® BCM57508 (optional) 2x 10GbE RJ45 with Intel® X550-AT2 (optional) 2x 10GbE SFP+ with Intel® X710-BM2 (optional) 2x 1GbE RJ45 with Intel® i350-AM2 (optional) 2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 4x 10GbE RJ45/SFP+ with Intel® X710-TM4 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 1GbE SFP or 4x 1GbE RJ45 with Intel® i350-AM4 (optional) 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional) via AIOM	2x 100GbE QSFP28 with Broadcom® BCM57508 (optional) 2x 10GbE RJ45 with Intel® X550-AT2 (optional) 2x 10GbE SFP+ with Intel® X710-BM2 (optional) 2x 1GbE RJ45 with Intel® i350-AM2 (optional) 2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 4x 10GbE RJ45/SFP+ with Intel® X710-TM4 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 10GbE SFP+ with Intel® XL710-BM1 (optional) 4x 1GbE SFP or 4x 1GbE RJ45 with Intel® i350-AM4 (optional) 4x 25GbE RJ45/SFP28 with Mellanox® CX-4 Lx EN Intel® X550-AT2 (optional) via AIOM
VGA/Audio	1 VGA port	None	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	24x 2.5" hot-swap NVMe/SATA/SAS drive bays; Optional RAID support via RAID Controller AOC	12x 3.5" hot-swap NVMe/SATA/SAS drive bays; Optional RAID support via RAID Controller AOC	8x 2.5" hot-swap NVMe/SATA/SAS drive bays; 8x 2.5" NVMe hybrid; Optional RAID support via RAID Controller AOC
Peripheral Bays	None	None	None
Power Supply	Redundant 1600W Titanium level (96%)	Redundant 1200W Titanium level (96%)	Redundant 1200W Titanium level (96%)
Cooling System	4x 8cm heavy duty fan(s)	4x 8cm heavy duty fan(s)	8x 4cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 436.88 x 88.9 x 760mm (17.2" x 3.5" x 29.9") Package: 625 x 253 x 1154mm (24.6" x 9.96" x	2U Rackmount Enclosure: 436.88 x 88.9 x 803mm (17.2" x 3.5" x 31.6") Package: 605 x 256 x 947mm (23.81" x 10.07" x	1U Rackmount Enclosure: 437 x 43 x 746mm (17.2" x 1.7" x 29.36") Package: 605 x 205 x 1025mm (23.81" x 7.99" x

37.28")

45.43")



3 hot-pluggable systems (nodes) in 2U







3 hot-pluggable systems (nodes) in 2U



MODEL	SYS-210SE-31A	SYS-210SE-31D
Processor Support	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported TDP up to 205W;	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported TDP up to 205W;
Key Applications	<ul> <li>Enterprise Edge Computing</li> <li>Telecom DRAN, CRAN, and Edge Core Application</li> <li>Flex-RAN, Open-RAN vBBU</li> <li>Multi-Access Edge Computing</li> </ul>	<ul> <li>Enterprise Edge Computing</li> <li>Telecom DRAN, CRAN, and Edge Core Application</li> <li>Flex-RAN, Open-RAN vBBU</li> <li>Multi-Access Edge Computing</li> </ul>
Outstanding Features	<ul> <li>Three front hot-swappable nodes with single CPU socket and 8 DIMM design</li> <li>Front access IO design, and tool less serviceability</li> <li>16.9" (430mm) chassis depth</li> </ul>	<ul> <li>Three front hot-swappable nodes with single CPU socket and 8 DIMM design</li> <li>Front access IO design, and tool less serviceability</li> <li>16.9" (430mm) chassis depth</li> </ul>
Serverboard	SUPER●® X12SPED-F	SUPER●® X12SPED-F
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8 DIMM slots Up to 2TB ECC RDIMM/LRDIMM, DDR4-3200MHz	8 DIMM slots Up to 2TB ECC RDIMM/LRDIMM, DDR4-3200MHz
Expansion Slots	2 PCle 4.0 x16 FHHL, PCle 4.0 x16 LP	2 PCle 4.0 x16 FHHL, PCle 4.0 x16 LP
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity		
VGA/Audio	1 VGA port	1 VGA port
Management	IPMI 2.0; SuperDoctor® 5	IPMI 2.0; SuperDoctor® 5
Drive Bays	0x NVMe drive bays;	0x NVMe drive bays;
Peripheral Bays	None	None
Power Supply	2000W AC Redundant PSU	2000W DC Redundant PSU
Cooling System	4 heavy duty fan(s)	4 heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 449 x 88 x 430mm (17.7" x 3.5" x 16.9") Package: 750 x 240 x 590mm (29.5" x 9.5" x 23.2")	2U Rackmount Enclosure: 449 x 88 x 430mm (17.7" x 3.5" x 16.9") Package: 750 x 240 x 590mm (29.5" x 9.5" x 23.2")











### 4 Nodes, Rear IO



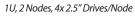
MODEL	SYS-F610P2-RTN	SYS-F620P3-RTBN
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 185W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 205W; 3 UPI
Key Applications	<ul> <li>Hyperscale / Hyperconverged</li> <li>Virtualization Server</li> <li>Scale-Out Storage</li> <li>Telco Data Center and ETSI certified</li> <li>Data Center Enterprise Applications</li> <li>HPC and Big Data</li> </ul>	<ul> <li>Hyperscale / Hyperconverged</li> <li>Virtualization Server (VSAN)</li> <li>High Capacity and Ultra Dense Storage</li> <li>Telco Data Center and ETSI certified</li> <li>Data Center Enterprise Applications</li> <li>HPC and Big Data</li> </ul>
Outstanding Features	<ul> <li>Shared power architecture for best efficiency</li> <li>Redundant cooling and power configurations for high availability</li> <li>Optimized designs for storage and compute density</li> <li>HDD hot-swap capability</li> <li>4U 8-node architecture with front serviceability from cold aisle for all nodes</li> </ul>	<ul> <li>Shared power architecture for best efficiency</li> <li>Redundant cooling and power configurations for high availability</li> <li>Optional 2x Additional Internal SSDs</li> <li>Optimized designs for storage and compute density</li> <li>HDD hot-swap capability</li> <li>4U 4-node architecture with front serviceability from cold aisle for all nodes</li> </ul>
Serverboard	SUPER●® X12DPFR-AN6	SUPER●® X12DPFR-AN6
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 2TB RDIMM/LRDIMM, DDR4-3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz	16 DIMM slots Up to 2TB RDIMM/LRDIMM, DDR4-3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz
Expansion Slots	M.2 slot(s) PCI-E 4.0 x8 LP slot(s)	AIOM slot(s) HBA slot(s) PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	1x 1GbE RJ45 (BMC) port(s) via AIOM	1x 1GbE RJ45 (BMC) port(s) via AlOM
VGA/Audio	1 VGA port, Aspeed AST2600 BMC	1 VGA port, Aspeed AST2600 BMC
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	6x 2.5" hot-swap NVMe/SATA/SAS drive bays; 6x 2.5" NVMe hybrid; 6x 2.5" 7mm drive bays	8x 3.5" hot-swap SATA/SAS drive bays; 8x 2.5" NVMe hybrid; 8x 2.5" 7mm drive bays
Peripheral Bays	None	None
Power Supply	2200W Titanium level (96%)	2200W Titanium level (96%)
Cooling System	3x 4cm heavy duty fan(s)	2x 8cm heavy duty fan(s)
Form Factor	4U Rackmount Enclosure: 448 x 177 x 737mm (17.63" x 6.96" x 29") Package: (28.3" x 15" x 42.4")	4U Rackmount Enclosure: 448 x 177 x 737mm (17.63" x 6.96" x 29") Package: (28.3" x 15" x 42.4")







1U, 2 Nodes, 4x 2.5" Drives/Node



1U, 2 Nodes, 4x 2.5" Drives/Node





			1
MODEL	SYS-120TP-DTTR	SYS-120TP-DC8TR	SYS-120TP-DC9TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI
Key Applications	<ul><li>Big Data / Big Science</li><li>Hyper-Converged Infrastructure</li><li>High Performance Computing</li></ul>	Big Data / Big Science Hyper-Converged Infrastructure High Performance Computing	Big Data / Big Science Hyper-Converged Infrastructure High Performance Computing
Outstanding Features	The most cost optimized 1U, 2 node solution	The most cost optimized 1U, 2 node solution	The most cost optimized 1U, 2 node solution
Serverboard	SUPER●® X12DPT-PT6	SUPER●® X12DPT-PT6	SUPER●® X12DPT-PT6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Broadcom® AOC-S3808L-L8IT	Broadcom® AOC-S3908L-H8IR-16DD
Connectivity			
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog	<ul><li>I&gt;ntel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></ul>	<ul><li>I&gt;ntel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></ul>
Drive Bays	4x 2.5" hot-swap SATA drive bays;	4x 2.5" hot-swap SATA/SAS drive bays;	4x 2.5" hot-swap SATA/SAS drive bays;
Peripheral Bays	None	None	None
Power Supply	1000W Titanium level (96%)	1000W Titanium level (96%)	1000W Titanium level (96%)
Cooling System	6x 4cm heavy duty fan(s)	6x 4cm heavy duty fan(s)	6x 4cm heavy duty fan(s)
Form Factor	1U Rackmount Enclosure: 438 x 43 x 718mm (17.25" x 1.7" x 28.25") Package: 752 x 203 x 975mm (29.6" x 8" x 38.4")	1U Rackmount Enclosure: 438 x 43 x 718mm (17.25" x 1.7" x 28.25") Package: 752 x 203 x 975mm (29.6" x 8" x 38.4")	1U Rackmount Enclosure: 438 x 43 x 718mm (17.25" x 1.7" x 28.25") Package: 752 x 203 x 975mm (29.6" x 8" x 38.4")



NEW! 3rd Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable processors Supported





2U, 4 Nodes, 6x 2.5" Drives/Node



MODEL	SYS-220TP-HTTR	SYS-220TP-HC8TR	SYS-220TP-HC9TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI
Key Applications	<ul><li>Big Data / Big Science</li><li>Hyper-Converged Infrastructure</li><li>High Performance Computing</li></ul>	Big Data / Big Science Hyper-Converged Infrastructure High Performance Computing	Big Data / Big Science Hyper-Converged Infrastructure High Performance Computing
Outstanding Features	The most cost optimized 2U, 4 node solution	The most cost optimized 2U, 4 node solution	The most cost optimized 2U, 4 node solution
Serverboard	SUPER●® X12DPT-PT6	SUPER●® X12DPT-PT6	SUPER●° X12DPT-PT6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Broadcom® AOC-S3808L-L8IT	Broadcom® AOC-S3908L-H8IR
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X710-AT2		
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog	<ul><li>Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></ul>	<ul><li>Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></ul>
Drive Bays	6x 2.5" hot-swap SATA drive bays;	6x 2.5" hot-swap SATA/SAS drive bays;	6x 2.5" hot-swap SATA/SAS drive bays;
Peripheral Bays	None	None	None
Power Supply	2200W Titanium level (96%)	2200W Titanium level (96%)	2200W Titanium level (96%)
Cooling System	4x 8cm heavy duty fan(s)	4x 8cm heavy duty fan(s)	4x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 438 x 88 x 730mm (17.25" x 3.47" x 28.75") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")	2U Rackmount Enclosure: 438 x 88 x 730mm (17.25" x 3.47" x 28.75") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")	2U Rackmount Enclosure: 438 x 88 x 730mm (17.25" x 3.47" x 28.75") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")



NEW! 3rd Gen Intel<sup>®</sup> Xeon<sup>®</sup> Scalable processors Supported



2U, 4 Nodes, 3x 3.5" Drives/Node

2U, 4 Nodes, 3x 3.5" Drives/Node



2U, 4 Nodes, 3x 3.5" Drives/Node



MODEL	SYS-620TP-HTTR	SYS-620TP-HC8TR	SYS-620TP-HC9TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA 4189 (Socket P+) supported TDP up to 185W; 2 UPI
Key Applications	<ul><li>Big Data / Big Science</li><li>Hyper-Converged Infrastructure</li><li>High Performance Computing</li></ul>	<ul><li>Big Data / Big Science</li><li>Hyper-Converged Infrastructure</li><li>High Performance Computing</li></ul>	<ul><li>Big Data / Big Science</li><li>Hyper-Converged Infrastructure</li><li>High Performance Computing</li></ul>
Outstanding Features	The most cost optimized 2U, 4 node solution	The most cost optimized 2U, 4 node solution	The most cost optimized 2U, 4 node solution
Serverboard	SUPER●® X12DPT-PT6	SUPER●® X12DPT-PT6	SUPER●® X12DPT-PT6
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	M.2 slot(s) 2 PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)	M.2 slot(s) PCI-E 4.0 x16 LP slot(s)
Onboard Storage Controller	Intel® SATA	Broadcom® AOC-S3808L-L8IT	Broadcom® AOC-S3908L-H8IR
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X710-AT2		
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog	<ul><li>I&gt;<li>Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></li></ul>	<ul><li>Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Supermicro Out of Band (OOB) Software License Key; Watch Dog</li></ul>
Drive Bays	3x 3.5" hot-swap SATA drive bays;	3x 3.5" hot-swap SATA/SAS drive bays;	3x 3.5" hot-swap SATA/SAS drive bays;
Peripheral Bays	None	None	None
Power Supply	2200W Titanium level (96%)	2200W Titanium level (96%)	2200W Titanium level (96%)
Cooling System	4x 8cm heavy duty fan(s)	4x 8cm heavy duty fan(s)	4x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 438 x 88 x 774mm (17.25" x 3.47" x 30.5") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")	2U Rackmount Enclosure: 438 x 88 x 774mm (17.25" x 3.47" x 30.5") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")	2U Rackmount Enclosure: 438 x 88 x 774mm (17.25" x 3.47" x 30.5") Package: 622 x 254 x 1143mm (24.5" x 10" x 45")













MODEL	SYS-240P-TNRT
Processor Support	3rd Gen Intel® Xeon® Scalable processors Quad Socket LGA-4189 (Socket P+) supported TDP up to 250W; 6 UPI up to 10.4GT/s
Key Applications	<ul> <li>SAP HANA</li> <li>HCI</li> <li>In-Memory Database</li> <li>Scientific Virtualization</li> <li>ERP, CRM</li> <li>Business Intelligence</li> <li>Artificial Intelligence (AI)</li> </ul>
Outstanding Features	<ul> <li>Large memory footprint for up to 18TB</li> <li>Flexible onboard networking options up to dual 10G Ethernet &amp; dual SFP+</li> <li>Flexible networking options with AIOM/OCP NIC 3.0 support</li> <li>24x 2.5" hybrid hot-swappable NVMe/SAS/SATA drive bays</li> </ul>
Serverboard	SUPER●® X12QCH+
Chipset	Intel® C621
System Memory (Max.)	48 DIMM slots Up to 12TB ECC LRDIMM, DDR4-3200MHz Up to 12TB ECC RDIMM, DDR4-3200MHz Up to 18TB Intel® DCPMM, DDR4-2666MHz
Expansion Slots	2 PCI-E 3.0 x16 FHFL slot(s) 2 PCI-E 3.0 x16 FHHL slot(s) 2 PCI-E 3.0 x8 FHFL slot(s) 4 PCI-E 3.0 x8 LP slot(s)
Onboard Storage Controller	Intel® SATA
Connectivity	2x 10GbE RJ45 and 2x 10GbE SFP+ port(s) with Intel® Ethernet Controller X710-TM4 100Gb QSFP 28 with AIOM (optional)
VGA/Audio	1 VGA port
Management	IPMI 2.0; NMI; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	24x 2.5" hot-swap NVMe/SAS3/SATA3 drive bays; 24x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC
Peripheral Bays	None
Power Supply	Redundant 2000W Titanium level (80%)
Cooling System	4x 8cm heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 439.5 x 89 x 803mm (17.3" x 3.5" x 31.6") Package: 672 x 250 x 1100mm (26.5" x 9.75" x 43.5")

# X12 SUPERWORKSTATIONS (For Complete System Only)





DP Workstation, 2-GPU Supported



DP Workstation, 2-GPU Supported



UP Workstation

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MODEL	SYS-740A-T	SYS-730A-I	SYS-540A-TR
Processor Support	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported TDP up to 270W; 3 UPI	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported TDP up to 270W; Intel® Xeon® W-3300 processors Single Socket LGA-4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Engineering/scientific research</li><li>Multimedia/Digital Content creation</li><li>CAD</li><li>Rendering</li></ul>	<ul><li>Engineering/scientific research</li><li>Multimedia/Digital Content creation</li><li>CAD</li><li>Rendering</li></ul>	Deep Learning/Al/Machine Learning Development
Outstanding Features	<ul> <li>Supports up to two double width active GPUs</li> <li>Front accessible storage with 8x 3.5"/2.5" hot-swap drive bays</li> </ul>	<ul> <li>Supports up to two double width active GPUs</li> <li>New front bezel with keylock for added security</li> <li>Compact and quiet operation</li> </ul>	<ul> <li>Versatile: Full Tower or 4U Rack mount form factor</li> <li>Robust: Features 7 PCI-E Gen 4 slots</li> <li>Powerful: Up to 4 double-width GPUs</li> <li>Flexible: Supports either active &amp; passive GPUs</li> </ul>
Serverboard	SUPER●® X12DAI-N6	SUPER●® X12DAI-N6	SUPER●® X12SPA-TF
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
System Memory (Max.)	16 DIMM slots Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz Up to 512GB Intel® DCPMM, DDR4-3200MHz	16 DIMM slots Up to 4 TB ECC LRDIMM, DDR4-3200MHz Up to 4 TB ECC RDIMM, DDR4-3200MHz Up to 512GB Intel® DCPMM, DDR4-3200MHz	16 DIMM slots Up to 4TB ECC LRDIMM, DDR4-3200MHz
Expansion Slots	PCI-E 4.0 x8 FHHL slot(s) 5 PCI-E 4.0 x16 FHFL slot(s)	PCI-E 4.0 x8 FHHL slot(s) 5 PCI-E 4.0 x16 FHFL slot(s)	7 PCI-E 3.0 x16 FHFL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA	Intel® C621A
Connectivity	2x 1GbE port(s)	2x 1GbE port(s)	1x 10GbE RJ45 port(s) with Marvell AQC113 1x 1GbE RJ45 port(s) with Intel® Ethernet Controller I210-AT 1x 1GbE RJ45 port(s) with Realtek RTL8211F PHY (dedicated IPMI)
VGA/Audio	1 VGA port	1 VGA port	1 VGA port
Management	IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog	IPMI 2.0; KVM with dedicated LAN; SPM; SUM; SuperDoctor 5; Watch Dog
Drive Bays	8x 3.5" hot-swap SATA (SAS/NVMe optional) drive bays; 4x 2.5" NVMe hybrid; Optional RAID support via RAID controller AOC	4x 3.5" NVme/SATA drive bays	8x 3.5" hot-swap SATA drive bays
Peripheral Bays	3x 5.25" (optional)	2x 5.25" (optional)	3x 5.25"
Power Supply	Redundant 1200W Titanium level (96%)	1200W Platinum level (92%)	Redundant 2200W Titanium level (96%)
Cooling System	2x 8cm heavy duty fan(s)	2x 12cm heavy duty fan(s)	4x 92mm hot-swap fans; 2x 80mm rear hot- swap exhaust PWM fans
Form Factor	4U Tower Rackmount Enclosure: 178 x 452 x 647mm (7" x 17.8" x 25.5") Package: 356 x 625 x 795mm (14" x 24.6" x 31.3")	Mid-Tower Rackmount Enclosure: 193 x 424 x 525.3mm (7.6" x 16.7" x 20.68") Package: 304 x 543 x 642mm (11.97" x 21.38" x 25.28")	Full-Tower Rackmount Enclosure: 178 x 460 x 673mm (7" x 18.1" x 26.5") Package: 685.8 x 322.6 x 952.5mm (27" x 12.7" x 37.5")

### X12WIO





### 2U UP WIO



### 1U UP WIO



MODEL	SYS-520P-WTR	SYS-110P-WTR
Processor Support	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Network Appliance</li><li>Database Processing and Storage</li><li>Data Center Optimized</li></ul>	<ul> <li>Virtualization</li> <li>Database Processing and Storage</li> <li>Data Center Optimized</li> <li>Enterprise Server</li> <li>Cloud Computing</li> </ul>
Outstanding Features	<ul> <li>Up to 6 expansion slots with optional riser card.</li> <li>Flexible I/O expansion.</li> </ul>	<ul> <li>Maximum I/O. Support 3 x16 expansion slots in 1U form factor.</li> <li>4x Gen4 NVMe drives supported in 1U Form Factor.</li> </ul>
Serverboard	SUPER●® X12SPW-TF	SUPER●® X12SPW-TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz
Expansion Slots	2 PCI-E 4.0 x16 FHFL slot(s) 2 PCI-E 4.0 x8 LP slot(s)	1 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x16 FHFL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM
Drive Bays	8x 3.5" SATA drive bays; 2x 2.5" NVMe dedicated;	10x 2.5" SATA drive bays; 4x 2.5" NVMe hybrid;
Peripheral Bays	2x 2.5"	None
Power Supply	Redundant 650W Platinum level (94%)	Redundant 750W Platinum level (94%)
Cooling System	3x (8cm x 8cm x 3.8cm) heavy duty fan(s)	5x (4cm x 4cm x 5.6cm) heavy duty fan(s)
Form Factor	2U Rackmount Enclosure: 437 x 89 x 647mm (17.2" x 3.5" x 25.5") Package: 673.1 x 279.4 x 863.6mm (26.5" x 11" x 34")	1U Rackmount Enclosure: 437 x 43 x 597mm (17.2" x 1.7" x 23.5") Package: 609.6 x 203.2 x 812.8mm (24" x 8" x 32")

### X12WIO

1U UP WIO 1U UP WIO







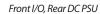


MODEL	SYS-510P-WT	SYS-510P-WTR
Processor Support	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;	Support Intel® 3rd Gen Xeon® Scalable Processors Single Socket LGA 4189 (Socket P+) supported TDP up to 270W;
Key Applications	<ul><li>Virtualization</li><li>Data Center Optimized</li><li>Enterprise Server</li><li>Cloud Computing</li></ul>	<ul><li>Virtualization</li><li>Data Center Optimized</li><li>Enterprise Server</li><li>Cloud Computing</li></ul>
Outstanding Features	<ul> <li>Maximum I/O. Support 3 x16 expansion slots in 1U form factor.</li> <li>Cost Effective</li> <li>4x NVMe drives supported in 1U Form Factor.</li> </ul>	<ul> <li>Maximum I/O. Support 3 x16 expansion slots in 1U form factor.</li> <li>4x NVMe drives supported in 1U Form Factor.</li> </ul>
Serverboard	SUPER●° X12SPW-TF	SUPER●® X12SPW-TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz	8 DIMM slots Intel® DCPMM, DDR4-3200MHz ECC LRDIMM, DDR4-3200MHz ECC RDIMM, DDR4-3200MHz
Expansion Slots	1 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x16 FHFL slot(s)	1 PCI-E 4.0 x16 LP slot(s) 2 PCI-E 4.0 x16 FHFL slot(s)
Onboard Storage Controller	Intel® SATA	Intel® SATA
Connectivity	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550	2x 10GbE RJ45 port(s) with Intel® Ethernet Controller X550
VGA/Audio	1 VGA port	1 VGA port
Management	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM	Intel® Node Manager; IPMI2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM
Drive Bays	4x 3.5" NVMe/SATA drive bays; 4x 3.5" NVMe hybrid;	4x 3.5" NVMe/SATA drive bays; 4x 3.5" NVMe hybrid;
Peripheral Bays	2x 2.5"	2x 2.5"
Power Supply	600W Platinum level (94%)	Redundant 500W Platinum level (94%)
Cooling System	5x (4cm x 4cm x 5.6cm) heavy duty fan(s)	5x (4cm x 4cm x 5.6cm) heavy duty fan(s)
Form Factor	1U Rackmount Enclosure: 437 x 43 x 650mm (17.2" x 1.7" x 25.6") Package: 596.9 x 215.9 x 855.98mm (23.5" x 8.5" x 33.7")	1U Rackmount Enclosure: 437 x 43 x 650mm (17.2" x 1.7" x 25.6") Package: 596.9 x 215.9 x 855.98mm (23.5" x 8.5" x 33.7")





### Front I/O, Front DC PSU







MODEL	SYS-110P-FDWTR	SYS-110P-FRDN2T
Processor Support	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU up to 38 cores and 205W TDP	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU up to 38 cores and 205W TDP
Key Applications	Telecom, Storage, GPU, DL/AI/ML	5G BBU DU applications, Telecom
Outstanding Features	<ul> <li>8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)</li> <li>2x PCI-E 4.0 x16 FHFL slots, 1x PCI-E 4.0 x16 low profile slot</li> <li>600W DC Redundant power supplies</li> <li>2x 10G Based-T LAN Ports</li> </ul>	<ul> <li>8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)</li> <li>2x PCI-E 4.0 x16 FHFL slots</li> <li>600W DC Redundant power supplies</li> <li>2x 10G Based-T LAN Ports</li> </ul>
Serverboard	SUPER●® X12SPW-TF	SUPER●® X12SPW-TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)	8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)
Expansion Slots	2x PCI-E 4.0 x16 FHFL slots 1x PCI-E 4.0 x16 low profile slot	2x PCI-E 4.0 x16 FHFL slots
Onboard Storage Controller	Intel SATA	Intel SATA
Connectivity	2x 10G Based-T LAN Ports	2x 10G Based-T LAN Ports
VGA/Audio	1x onboard VGA port	1x onboard VGA port
Management	KVM with dedicated LAN, Super Doctor, Watch Dog, Redfish API	KVM with dedicated LAN, Super Doctor, Watch Dog, Redfish API
Drive Bays	2x Internal 2.5" SATA drive bays	2x Internal 2.5" SATA drive bays
Peripheral Bays	N/A	N/A
Power Supply	600W DC Redundant power supplies	600W DC Redundant power supplies
Cooling System	6x (40x40x56 mm) cooling fans	5x (40x40x56 mm) cooling fans
Form Factor	1U rackmount (Front I/O) Enclosure: 437 x 429 x 43mm (17.2" x 16.9" x1.7")	1U rackmount (Front I/O) Enclosure: 437 x 399 x 43mm (17.2" x 15.7" x1.7")





### Front I/O, Rear AC Power

2U Compact Rackmount





MODEL	SYS-110P-FRN2T	SYS-210P-FRDN6T
Processor Support	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU up to 38 cores and 205W TDP	Single Socket supported TDP up to 270W;
Key Applications	5G BBU DU applications, Telecom	<ul><li>Cloud Computing</li><li>Network Function Virtualization</li><li>Al Inference and Machine Learning</li><li>5G Core and Edge</li></ul>
Outstanding Features	<ul> <li>8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)</li> <li>2x PCI-E 4.0 x16 FHFL slots</li> <li>800W AC Redundant power supplies</li> <li>2x 10G Based-T LAN Ports</li> </ul>	
Serverboard	SUPER●® X12SPW-TF	SUPER●® X12SPM-LN6TF
Chipset	Intel® C621A	Intel® C621A
System Memory (Max.)	8-DIMM, DDR4 -3200MHz, ECC, RDIMM(3DS), LRDIMM(3DS)	8 DIMM slots Up to 2TB ECC LRDIMM, DDR4-3200MHz Up to 2TB ECC RDIMM, DDR4-3200MHz
Expansion Slots	2x PCI-E 4.0 x16 FHFL slots	2 PCI-E 4.0 x16 FHHL slot(s) PCI-E 4.0 x16 FHHL in certain configurations slot(s) PCI-E 4.0 x16 Low Profile or 2 x8 Low Profile slot(s) PCI-E 4.0 x8 FHHL in certain configurations slot(s)
Onboard Storage Controller	Intel SATA	Intel® SATA
Connectivity	2x 10G Based-T LAN Ports	2x 1/10GbE and 4x 1GbE port(s)
VGA/Audio	1x onboard VGA port	1 VGA port
Management	KVM with dedicated LAN, Super Doctor, Watch Dog, Redfish API	Intel® Node Manager; IPMI 2.0; KVM with dedicated LAN; NMI; Redfish API; SPM; SSM; SUM; SuperDoctor® 5; Watch Dog
Drive Bays	2x Internal 2.5" SATA drive bays	2x 2.5" hot-swap SATA drive bays;
Peripheral Bays	N/A	None
Power Supply	800W AC Redundant power supplies	600W DC Redundant PSU
Cooling System	5x (40x40x56 mm) cooling fans	4 heavy duty fan(s)
Form Factor	1U rackmount (Front I/O) Enclosure: 437 x 399 x 43mm (17.2" x 15.7" x1.7")	2U Rackmount Enclosure: 436.88 x 88.9 x 298.8mm (17.2" x 3.5" x 11.8") Package: 490 x 188 x 590mm (19.3" x 7.4" x 23.3")



3rd Gen Intel® Xeon® Scalable processors Supported











MODEL	X12DPi-N6	X12DPi-NT6	X12DPL-i6	X12DPL-NT6
	3rd Gen Intel® Xeon® Scalable processors	3rd Gen Intel® Xeon® Scalable processors	3rd Gen Intel® Xeon® Scalable processors	3rd Gen Intel® Xeon® Scalable processors
Processor	Dual Socket LGA-4189 (Socket P+)	Dual Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP, 3 UPI up to 11.2 GT/s	Dual Socket LGA-4189 (Socket P+)	Dual Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 185W TDP, 2 UPI up to 11.2 GT/s
	Intel® C621A	Intel® C621A	Intel® C621A	Intel® C621A
Form Factor	E-ATX, 12" x 13" (30.48cm x 33.02cm)	E-ATX, 12`" x 13" (30.48cm x 33.02cm)	ATX, 12.23" x 10" (31.06cm x 25.4cm)	ATX, 12.23" x 10" (31.06cm x 25.4cm)
Memory Capacity & Slots	Up to 4TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz, in 18 DIMM slotsP1-DIMMB2 and P2-DIMMB2 are reserved for Intel Optane Persistent Memory 200 Series only.	Up to 4TB RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4- 3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz, in 18 DIMM slotsP1-DIMMB2 and P2-DIMMB2 are reserved for Intel Optane Persistent Memory 200 series only.	Up to 2TB RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4- 3200MHz, in 8 DIMM slots	Up to 2TB RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4- 3200MHz, in 8 DIMM slots
Expansion Slots	2 PCI-E 4.0 x8, 4 PCI-E 4.0 x16,	2 PCI-E 4.0 x8, 4 PCI-E 4.0 x16,	4 PCI-E 4.0 x16  M.2 Interface: 2 PCI-E 4.0 x4  M.2 Form Factor: 2280/22110, 2280  M.2 Key: M-Key	4 PCI-E 4.0 x16, 1 PCI-E 4.0 NVMe x8 Internal Port(s) M.2 Interface: 2 PCI-E 4.0 x4 M.2 Form Factor: 2280/22110, 2280 M.2 Key: M-Key
Onboard RAID Controller		Intel® C621A controller for 14 SATA3 (6 Gbps) ports; RAID 0,1,5,10 Dual LAN with 10GBase-T with	Intel® C621A controller for 12 SATA3 (6 Gbps) ports; RAID 0,1,5,10 Dual LAN with Intel® i210 Gigabit	Intel® C621A controller for 12 SATA3 (6 Gbps) ports; RAID 0,1,5,10 Dual LAN with Intel® X550
	Ethernet Controller	Intel® X550	Ethernet Controller	10GBase-T Ethernet Controller
Unnoard VGA	2 VGA (1 rear bezel, 1 front panel) ports,	2 VGA (1 rear bezel, 1 front panel) ports,	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC
USB Ports	2 USB 2.0 ports (2 via headers) 7 USB 3.2 Gen1 ports (4 rear + 2 via headers + 1 Type A)	2 USB 2.0 ports (2 via headers) 7 USB 3.2 Gen1 ports (4 rear + 2 via headers + 1 Type A)	5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)
Other Onboard I/O	TPM 2.0 Header 2 COM Ports (1 rear, 1 header)	TPM 2.0 Header 2 COM Ports (1 rear, 1 header)	2 ports SuperDOM TPM 2.0 Header 1 COM Port (1 header)	2 ports SuperDOM TPM 2.0 Header 1 COM Port (1 header)
Manageability	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring	+12V, +3.3V, +5V, +5V standby, 3.3V standby, 8 -fan status, Chassis	+12V, +3.3V, +5V, +5V standby, 3.3V standby, 8 -fan status, Chassis intrusion header, CPU temperature, LAN temperature, Memory temperature, Memory Voltages, Monitors CPU voltages, PCH temperature, System temperature, VBAT, VRM temperature	+12V, +3.3V, +5V, +5V standby, 3.3V standby, 8 -fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility	+12V, +3.3V, +5V, +5V standby, 3.3V standby, 8 -fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility
Other Features	ACPI power management, ATX Power connector, Chassis intrusion header, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, NCSI header, Node Manager Support, RoHS, RoT, SDDC, UID, WOL	ACPI power management, ATX Power connector, Chassis intrusion header, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, NCSI header, Node Manager Support, RoHS, RoT, SDDC, UID, WOL AMI UEFI	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, NCSI header, Node Manager Support, RoT, UID AMI UEFI	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, NCSI header, Node Manager Support, RoT, UID AMI UEFI

NEW! 3rd Gen Intel® Xeon® Scalable processors



WIO Workstation







4 GPUs

MODEL	X12DAi-N6	X12DDW-A6	X12DPG-QT6
Processor	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP, 3 UPI up to 11.2 GT/s	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP, 3 UPI up to 11.2 GT/s	3rd Gen Intel® Xeon® Scalable processors Dual Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP, 3 UPI up to 11.2 GT/s
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
Form Factor	E-ATX, 12" x 13" (30.48cm x 33.02cm)	Proprietary WIO, 12.288" x 13.404" (31.21cm x 34.05cm)	Proprietary, 15.12" x 13.2" (38.4cm x 33.53cm)
Memory Capacity & Slots	Up to 4TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 6TB Intel® Optane™ Persistent Memory, DDR4-3200MHz, in 16 DIMM slots; Up to 6TB Intel® Optane™ DC Persistent Memory in memory mode.	Up to 4TB RDIMM, DDR4-3200MHz; Up to 4TB LRDIMM, DDR4-3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz (OC), in 16 DIMM slots	Up to 4TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 6TB Intel® Optane™ Persistent Memory, in 16 DIMM slots; Up to 6TB Intel® Optane™ DC Persistent Memory in memory mode.
Expansion Slots	5 PCI-E 4.0 x16, 1 PCI-E 4.0 x8, 4 PCI-E 4.0 NVMe x4 Internal Port(s) <b>M.2 Interface:</b> 2 PCI-E 4.0 x4, RAID 0 & 1 <b>M.2 Form Factor:</b> 2280/22110 <b>M.2 Key:</b> M-Key	1 PCI-E 4.0 x16 Left Riser Slot, 1 PCI-E 4.0 x16 Right Riser Slot, 2 PCI-E 4.0 x16 Center Right Hand Slot, 8 PCI-E 4.0 NVMe Internal Port(s) M.2 Interface: 2 PCI-E 2.0 x1 M.2 Form Factor: 2260/2280 M.2 Key: M-Key 2 PCI-E 4.0 x16, AIOM slots Superset of OCP 3.0 Expansion	6 PCI-E 4.0 x16, 1 PCI-E 4.0 x8 <b>M.2 Interface:</b> 2 PCI-E 4.0 x4, RAID 0 & 1 <b>M.2 Form Factor:</b> 2242/2260/2280/22110 <b>M.2 Key:</b> M-Key
Onboard RAID Controller	Intel® C621A controller for 8 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10
Onboard LAN	Dual LAN with Intel® i210 Gigabit Ethernet Controller	AIOM for LAN	Dual LAN with Intel® X550 10GBase-T Ethernet Controller
Onboard VGA	1 VGA D-Sub Connector port, ASPEED AST2600 BMC	1 VGA D-Sub Connector port, ASPEED AST2600 BMC	1 VGA D-Sub Connector port, ASPEED AST2600 BMC
USB Ports	6 USB 3.2 Gen1 ports (4 rear + 2 via headers)2 USB 3.2 Gen2 ports (1 Rear Type A	4 USB 3.1 Gen1 ports(2 rears, 2 via headers)	2 USB 2.0 ports (2 via headers) 6 USB 3.1 Gen1 ports (3 Rears Type A + 1 Rear Type C, 1 via header, 1 via header, 1 Type A) 6 USB 3.2 Gen1 ports (4 rear + 1 via header + 1 Type A)
Other Onboard I/O Devices	7.1 HD Audio TPM 2.0 Header 1 COM Port (1 header)	TPM Header 1 COM Port (1 header)	2 ports SuperDOM 7.1 HD Audio Header TPM 2.0 Header 2 COM Ports (1 rear, 1 header)
Manageability	Intel® Node Manager, IPMI (Intelligent Platform Management Interface) v2.0 with KVM support, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI (Intelligent Platform Management Interface) v2.0 with KVM support, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, SuperDoctor® III, vPro, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring	+12V, +3.3V, +5V, +5V standby, 8 -fan status, CPU, CPU temperature, Memory temperature, Memory Voltages, Monitors CPU voltages, PCH temperature, System temperature, VBAT, VRM temperature	+1.8V PCH, +12V, +5V standby, 6 -fan status, Chassis intrusion header, CPU temperature, CPU thermal trip support, Memory Voltages, Monitors CPU voltages, PCH temperature	+1.8V, +12V, +3.3V, +5V, +5V standby, 10 -fan status, 5+1 Phase-switching voltage regulator, Chassis intrusion header, HT, Supports system management utility, VBAT
Other Features	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, CPU thermal trip support for processor protection, NCSI header, Node Manager Support, RoHS, RoT, UID, WOL	ACPI power management, ATX Power connector, Chassis intrusion detection, NCSI header, Node Manager Support, RoHS, RoT, UID, WOL	Chassis intrusion detection, CPU thermal trip support for processor protection, Node Manager Support, RoHS
BIOS	AMI UEFI	AMI UEFI	AMI UEFI

NEW!
3rd Gen
Intel <sup>®</sup> Xeon <sup>®</sup>
Scalable
processors
Supported





1U Optimized



1U Optimized



Embedded, High Performance Quad 1GbE LAN



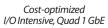
Embedded, High Performance Dual 25G SFP28

MODEL	X12SPO-F	X12SPO-NTF	X12SPZ-LN4F	X12SPZ-SPLN6F
Processor		3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP
Chipset	Intel® C621A	Intel® C621A	Intel® C621A	Intel® C621A
Form Factor  Memory Capacity & Slots	12" x 10" (30.48cm x 25.4cm) Up to 2TB 3DS ECC RDIMM, DDR4- 3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz	ATX, 12" x 10" (30.48cm x 25.4cm) Up to 2TB 3DS ECC RDIMM, DDR4- 3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots	Memory 200 Series, in 8 DIMM slots	Memory, in 8 DIMM slots
Expansion Slots		1 PCI-E 4.0 x16, 5 PCI-E 4.0 NVMe x8 Internal Port(s) <b>M.2 Interface:</b> 2 SATA/PCI-E 3.0 x4 <b>M.2 Form Factor:</b> 2280/22110 <b>M.2 Key:</b> M-Key	2 PCI-E 4.0 x16, 1 PCI-E 4.0 NVMe x8 SlimSAS Internal Port(s), 1 PCI-E 4.0 NVMe x4 Internal Port(s), 1 PCI-E 3.0 NVMe x4 Internal Port(s) 1 M.2 M-Key SATA/PCI-E 3.0 x4, 2242/2280	1 PCI-E 3.0 NVMe x4 Internal Port(s) 1 M.2 M-Key SATA/PCI-E 3.0 x4, 2242/2280
Onboard RAID Controller	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 6 SATA3 (6 Gbps) ports; 4 SATA ports via OCuLink; RAID 0,1,5,10	Intel® C621A controller for 6 SATA3 (6 Gbps) ports; 4 SATA ports via OCuLink; RAID 0,1,5,10
Onboard LAN	Dual LAN with Intel® i350 Gigabit Ethernet Controller	Dual LAN with Intel® X550 10GBase-T Ethernet Controller	Quad LAN with 1GbE with Intel® I350-AM4	Quad LAN with 1GbE with Intel® 1350-AM4 Dual LAN with Broadcom BCM57414 25G SFP28
Onboard VGA	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC	1 VGA port,	1 VGA port,
USB Ports	headers)	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	4 USB 2.0 ports (4 via headers) 4 USB 3.2 Gen1 ports (2 rear + 2 via headers)	4 USB 2.0 ports (4 via headers) 4 USB 3.2 Gen1 ports (2 rear + 2 via headers)
Other Onboard I/O Devices	TPM Header 2 COM Ports (1 rear, 1 header)	TPM Header 2 COM Ports (1 rear, 1 header)	TPM Header & Chip both 1 COM Port (1 header)	TPM Header & Chip both 1 COM Port (1 header)
Manageability	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI (Intelligent Platform Management Interface) v2.0 with KVM support, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI (Intelligent Platform Management Interface) v2.0 with KVM support, KVM with dedicated LAN, NMI, SPM, SSM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring		3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors CPU	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 6 -fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility, VBAT 12V DC or ATX Power Source, ACPI power management, Control	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 6-fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility, VBAT 12V DC or ATX Power Source, ACPI power management, Control
Other Features	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, RoHS, RoT, UID, WOL	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, ROHS, ROT, UID, WOL	of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, M.2 NGFF connector, Node Manager Support, RoHS	of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, Dual Cooling Zones, M.2 NGFF connector, Node Manager Support, ROHS
BIOS	AMI UEFI	AMI UEFI	256Mb SPI Flash with AMI BIOS	256Mb SPI Flash with AMI BIOS

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WIO, 3 AOC in 1U, Dual 1 GbE

WIO, 3 AOC in 1U, Dual 10 GbE







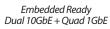


MODEL	X12SPL-F	X12SPL-LN4F	X12SPW-F	X12SPW-TF
Processor	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP		3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP
Chipset	Intel® C621A	Intel® C621A	Intel® C621A	Intel® C621A
Form Factor	ATX, 12.1" x 10" (30.73cm x 25.4cm)	ATX, 12.1" x 10" (30.73cm x 25.4cm)	Proprietary WIO, 8" x 13" (20.32cm x 33.02cm)	Proprietary WIO, 8" x 13" (20.32cm x 33.02cm)
Memory Capacity & Slots  Expansion Slots	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots 2 PCI-E 4.0 x8, 1 PCI-E 4.0 x16, 1 PCI-E 4.0 x8 (in x16 slot) 3 PCI-E 3.0 x8 M.2 Interface: 1 SATA/PCI-E 3.0 x4 M.2 Form Factor: 2280/22110 M.2 Key: M-Key	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots 2 PCI-E 4.0 x8, 1 PCI-E 4.0 x16, 1 PCI-E 4.0 x8 (in x16 slot) 3 PCI-E 3.0 x8 M.2 Interface: 1 SATA/PCI-E 3.0 x4 M.2 Form Factor: 2280/22110 M.2 Key: M-Key	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots 1 PCI-E 4.0 x16 Right Riser Slot, 1 PCI-E 4.0 x32 Left Riser Slot, 4 PCI-E 4.0 NVMe x4 Internal Port(s) M.2 Interface: PCI-E 3.0 x4 and SATA M.2 Form Factor: 2280, 22110 M.2 Key: M-Key	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots 1 PCI-E 4.0 x16 Right Riser Slot, 1 PCI-E 4.0 x32 Left Riser Slot, 4 PCI-E 4.0 NVMe x4 Internal Port(s) M.2 Interface: PCI-E 3.0 x4 and SATA M.2 Form Factor: 2280, 22110 M.2 Key: M-Key
Onboard RAID Controller	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10
Onboard LAN	Dual LAN with Intel® i210 Gigabit Ethernet Controller	Quad LAN with Intel® i210 Gigabit Ethernet Controller	Dual LAN with 1GbE with Intel® I210	Dual LAN with 10GBase-T with Intel® X550
Onboard VGA	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC
USB Ports	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	4 USB 2.0 ports (2 rear + 2 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	4 USB 2.0 ports (2 rear + 2 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)
Other Onboard I/O Devices	TPM Header 1 COM Port (1 header)	TPM Header 1 COM Port (1 header)	2 ports SuperDOM TPM Header 2 COM Ports (1 rear, 1 header)	2 ports SuperDOM TPM Header 2 COM Ports (1 rear, 1 header)
Manageability	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring	3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors CPU	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors CPU voltages, System temperature, VBAT	3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors CPU voltages, Supports system management utility, VBAT
Other Features	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, RoHS, RoT, UID, WOL	ACPI power management, ATX Power connector, Chassis intrusion detection, Chassis intrusion header, RoHS, RoT, UID, WOL	ACPI power management, Control of power-on for recovery from AC power loss, RoHS, UID, WOL	ACPI power management, Control of power-on for recovery from AC power loss, RoHS, UID, WOL
BIOS	AMI UEFI	AMI UEFI	AMI UEFI	AMI UEFI









Embedded Ready Dual 10GbE







MODEL	X12SPM-LN4F	X12SPM-LN6TF	X12SPM-TF
Processor	3rd Gen Intel® Xeon® Scalable Processors; Single Socket LGA-4189 (Socket P+) supported, CPU TDP support up to 270W TDP	3rd Gen Intel® Xeon® Scalable Processors; Single Socket LGA-4189 (Socket P+) supported, CPU TDP support up to 270W TDP	3rd Gen Intel® Xeon® Scalable Processors; Single Socket LGA-4189 (Socket P+) supported, CPU TDP support up to 270W TDP
Chipset	Intel® C621A	Intel® C621A	Intel® C621A
Form Factor	microATX 9.6" x 9.6" (24.38cm x 24.38cm)	microATX, 9.6" x 9.6" (24.38cm x 24.38cm)	microATX, 9.6" x 9.6" (24.38cm x 24.38cm)
Memory Capacity & Slots	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots	Up to 2TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots
Expansion Slots	1 PCI-E 4.0 x8, 2 PCI-E 4.0 x16, 4 PCI-E 4.0 NVMe x4 Internal Port(s) <b>M.2 Interface:</b> 1 SATA/PCI-E 3.0 x4 <b>M.2 Form Factor</b> : 2280, 22110 <b>M.2 Key:</b> M-Key	1 PCI-E 4.0 x8, 2 PCI-E 4.0 x16, 4 PCI-E 4.0 NVMe x4 Internal Port(s) <b>M.2 Interface:</b> 1 SATA/PCI-E 3.0 x4 <b>M.2 Form Factor:</b> 2280, 22110 <b>M.2 Key:</b> M-Key	1 PCI-E 4.0 x8, 2 PCI-E 4.0 x16, 4 PCI-E 4.0 NVMe x4 Internal Port(s) <b>M.2 Interface:</b> 1 SATA/PCI-E 3.0 x4 <b>M.2 Form Factor:</b> 2280, 22110 <b>M.2 Key:</b> M-Key
Onboard RAID Controller	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10
Onboard LAN	Quad LAN with 1GbE with Intel® I350-AM4	Quad LAN with 1GbE with Intel® I350-AM4 Dual LAN with 10GBase-T with Intel® X550	Dual LAN with 10GBase-T with Intel® X550
Onboard VGA	1 VGA port ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC	1 VGA port, ASPEED AST2600 BMC
USB Ports	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	6 USB 2.0 ports (2 rear + 4 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)
Other Onboard I/O Devices	2 ports SuperDOM TPM Header 1 COM Port (1 header)	2 ports SuperDOM TPM Header 1 COM Port (1 header)	2 ports SuperDOM TPM Header 1 COM Port (1 header)
Manageability	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SUM, SuperDoctor® 5, Watchdog	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, NMI, SPM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 5 -fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility, VBAT	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 5-fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility, VBAT	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 5-fan status, Chassis intrusion header, Monitors CPU voltages, Supports system management utility, VBAT
Other Features	ACPI power management, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, M.2 NGFF connector, RoHS, UID, WOL	ACPI power management, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, M.2 NGFF connector, RoHS, UID, WOL	ACPI power management, Control of power-on for recovery from AC power loss, CPU thermal trip support for processor protection, M.2 NGFF connector, RoHS, UID, WOL
BIOS	AMI UEFI	AMI UEFI	AMI UEFI

NEW! 3rd Gen Intel® Xeon® Scalable processors Supported



#### High Performance







MODEL	X12SPi-TF	X12SPA-TF
Processor	3rd Gen Intel® Xeon® Scalable processors Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP	3rd Gen Intel® Xeon® Scalable processors, Intel® Xeon® W-3300 Processor Single Socket LGA-4189 (Socket P+) supported, CPU TDP supports Up to 270W TDP
Chipset	Intel® C621A	Intel® C621A
Form Factor	ATX, 12.1" x 10" (30.73cm x 25.4cm)	E-ATX, 13" x 12" (33.02cm x 30.48cm)
Memory Capacity & Slots	Up to 2TB RDIMM, DDR4-3200MHz; Up to 2TB LRDIMM, DDR4-3200MHz Up to 2TB Intel® Optane™ Persistent Memory, in 8 DIMM slots	Up to 4TB 3DS ECC RDIMM, DDR4-3200MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-3200MHz Up to 4TB Intel® Optane™ Persistent Memory, DDR4-3200MHz, in 16 DIMM slots
Expansion Slots	2 PCI-E 4.0 x16, 2 PCI-E 4.0 x8, 1 PCI-E 4.0 x8 (in x16 slot), 1 PCI-E 4.0 NVMe x8 Internal Port(s) <b>M.2 Interface:</b> 1 SATA/PCI-E 3.0 x4 <b>M.2 Form Factor:</b> 2280/22110 <b>M.2 Key:</b> M-Key	4 PCI-E 4.0 x16, 3 PCI-E 4.0 x8 (in x16 slot) <b>M.2 Interface:</b> 4 PCI-E 4.0 x4 <b>M.2 Form Factor:</b> 2260/2280/22110 <b>M.2 Key:</b> M-Key M.2 support to RAID 0,1, 5, 10, VROC key is required for RAID.
Onboard RAID Controller	Intel® C621A controller for 10 SATA3 (6 Gbps) ports; RAID 0,1,5,10	Intel® C621A controller for 8 SATA3 (6 Gbps) ports; RAID 0,1,5,10
Onboard LAN	Dual LAN with 10GBase-T with Intel® X550	Single LAN with Intel® Ethernet Controller I210-AT Single LAN with Marvell AQC113 Single LAN with Realtek RTL8211F PHY (dedicated IPMI)
Onboard VGA	1 VGA D-Sub Connector port, ASPEED AST2600 BMC	1 VGA port, VGA connector is dedicated for IPMI., ASPEED AST2500 BMC
USB Ports	4 USB 2.0 ports (2 rear + 2 via headers) 5 USB 3.2 Gen1 ports (2 rear + 2 via headers + 1 Type A)	4 USB 2.0 ports (2 rear + 2 via headers) 6 USB 3.2 Gen1 ports (4 rear + 2 via headers) 2 USB 3.2 Gen2 ports (1 Type A, 1 Type C) 1 USB 3.2 Gen2x2 ports (1 Type C); USB 3.2 Gen2 (1 Type A Vertical, 1 Type C header)
Other Onboard I/O Devices	TPM Header 1 COM Port (1 header)	ALC 888S HD Audio TPM 2.0 Header 2 COM Ports (1 rear, 1 header)
Manageability	Intel® Node Manager, IPMI2.0, KVM with dedicated LAN, SPM, SSM, SUM, SuperDoctor® 5, Watchdog	IPMI (Intelligent Platform Management Interface) v2.0 with KVM support, SPM, SUM, SuperDoctor® 5, Watchdog
PC Health Monitoring	+1.8V, +12V, +3.3V, +5V, +5V standby, 3.3V standby, 7-fan status, Chassis intrusion header, HT, Monitors CPU voltages, System temperature, VBAT	+1.8V, +12V, +3.3V, +5V, +5V standby, 10 -fan status, 3.3V standby, HT, Memory, VBAT
Other Features	ACPI power management, ATX Power connector, Chassis intrusion detection, Dual Cooling Zones, NCSI header, RoHS, RoT, UID	N/A
BIOS	AMI UEFI	256Mb SPI Flash with AMI BIOS



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Super Micro Computer, B.V.

Tel: +31-73-640-0390

Fax: +31-73-641-6525

Het Sterrenbeeld 12, 5215 ML,

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General Info: sales\_europe@supermicro.com

Support: Support\_Europe@supermicro.com



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#### **Worldwide Headquarters**

**U.S. East Coast Office** 

Super Micro Computer, Inc.

Jersey City, NJ 07310 USA

525 Washington Blvd, 20th Floor

 $General\ Info: Marketing@Supermicro.com$ 

Super Micro Computer, Inc.
980 Rock Avenue, San Jose, CA 95131 USA
Tel: +1-408-503-8000
Fax: +1-408-503-8008
Grechal Info: Marketing@Supermicro.com
Tech Support: Support@Supermicro.com
Webmaster Webmaster@Supermicro.com

### U.K. Sales Office

Super Micro Computer, B.V.
77 New Cavendish Street,
The Harley Building,
London, W1W 6XB
Tel: +31-73-640-0390 Ext. 2800
General Info: Sales@Supermicro.nl
Support: Support\_Europe@supermicro.com

#### Taiwan Office

Super Micro Computer, Inc.
3F., No.150, Jian 1st Rd., Zhonghe Dist.,
New Taipei City 235, Taiwan (R.O.C.)
Tel: +886-2-8226-3990
Fax: +886-2-8226-3992
Support: Support@Supermicro.com.tw

#### Supermicro Science & Technology Park Shanghai, China Office

Super Micro Computer, Inc.

No.1899, Xingfeng Rd., Bade Dist.,
Taoyuan City 334, Taiwan (R.O.C.)
Tel: +886-2-8226-3990
Fax: +886-3-362-8266
Support: Support@Supermicro.com.tw

Tech Support: +86-21-61152556
F-mail: Sales-CN@supermicro.com
Support: support-cn@supermicro.com
Support: support-cn@supermicro.com

### Beijing, China Office Japan Office

Supermicro Technology (Beijing) Co., Ltd

Suite 1208, Tower D, Jiahua Building,

E-mail: Sales-CN@supermicro.com

No. 9, Shangdi 3rd Street,

Haidian District, Beijing,

P.R. CHINA 100085 Tel: +86-10-62969165 Supermicro Japan
21F Shibuya Infoss Tower, 20-1,
Sakuragaoka-cho, Shibuya-Ku,Tokyo,
150-0031 Japan
Tel: +81-3-5728-5196
Fax: +81-3-5728-5197
Sales inquiry: Sales\_Inquiry\_JP@Supermicro.com
Tech Support: Support\_Japan@Supermicro.com

#### Korea Office

Super Micro Computer Holding B.V. #1001, Trade Tower, 511, Yeongdong-daero, Gangnam-gu, Seoul, Korea, 06164 Tel: +82-2-554-0045 Fax: +82-2-554-0146 Sales Inquiry: Sales-Asia@supermicro.com.tw

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### **Worldwide Headquarters**

Super Micro Computer, Inc. 980 Rock Ave.

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Fax: +1-408-503-8008

E-mail: Marketing@Supermicro.com

### **EMEA Headquarters**

Super Micro Computer, B.V. Het Sterrenbeeld 28, 5215 ML, 's-Hertogenbosch, The Netherlands

Tel: +31-73-640-0390

Fax: +31-73-641-6525

E-mail: Sales Europe@supermicro.com

### **APAC Headquarters**

Super Micro Computer, Taiwan Inc. 3F, No. 150, Jian 1st Rd., Zhonghe Dist., New Taipei City 235, Taiwan

Tel: +886-2-8226-3990

Fax: +886-2-8226-3991

E-mail: Marketing@Supermicro.com.tw



